

Dell PowerEdge R760xd2

Technical Guide

Notes, cautions, and warnings

 **NOTE:** A NOTE indicates important information that helps you make better use of your product.

 **CAUTION:** A CAUTION indicates either potential damage to hardware or loss of data and tells you how to avoid the problem.

 **WARNING:** A WARNING indicates a potential for property damage, personal injury, or death.

Chapter 1: System overview.....	5
Key workloads.....	5
New technologies.....	5
Chapter 2: System features and generational comparison.....	7
Chapter 3: Chassis views and features.....	9
Front view of the system.....	9
Rear view of the system.....	10
Inside the system.....	12
Quick Resource Locator.....	19
Chapter 4: Processor.....	20
Processor features	20
Supported processors.....	20
Chapter 5: Memory subsystem.....	21
Supported memory.....	21
Chapter 6: Storage.....	22
Storage controllers.....	22
Storage controller feature matrix.....	22
Supported Drives.....	23
Internal storage configuration.....	24
External Storage.....	24
Chapter 7: Networking.....	25
Overview.....	25
OCP 3.0 support.....	25
Supported OCP cards.....	25
OCP NIC 3.0 vs. rack Network Daughter Card comparisons.....	26
OCP form factors.....	26
Chapter 8: PCIe subsystem.....	29
PCIe risers.....	29
Chapter 9: Power, thermal, and acoustics.....	30
Power.....	30
Power Supply Units.....	31
Thermal.....	32
Thermal design.....	32
Acoustics.....	33
Acoustical performance.....	33

PowerEdge acoustical specifications.....	35
Chapter 10: Rack, rails, and cable management.....	43
Rails and cable management information.....	43
Chapter 11: Operating Systems and Virtualization.....	50
Supported Operating Systems.....	50
Chapter 12: Dell OpenManage Systems Management.....	51
Integrated Dell Remote Access Controller (iDRAC).....	51
Systems Management software support matrix.....	52
Chapter 13: Appendix D: Service and support.....	54
Default support levels.....	54
Default deployment levels.....	54
Other services and support information.....	54
Dell deployment services.....	54
Dell custom deployment Services.....	58
Dell Residency Services.....	58
Dell Data Migration Services.....	58
Dell Enterprise Support Services.....	59
Enterprise connectivity.....	61
Dell TechDirect.....	62
Dell Technologies Consulting Services.....	62
Chapter 14: Appendix A: Additional specifications.....	64
Chassis dimensions	64
Chassis weight.....	65
NIC port specifications.....	65
Video specifications.....	65
USB Ports.....	66
Internal USB.....	69
PSU rating.....	69
Environmental specifications.....	70
Thermal restriction matrix.....	72
Thermal air restrictions.....	74
Chapter 15: Appendix A. Standards compliance.....	75
Chapter 16: Appendix C Additional resources.....	76

System overview

The Dell PowerEdge R760xd2 is Dell's latest 2-socket storage-optimized rack server that is designed to run complex workloads using highly scalable memory, I/O, and network options.

The system features:

- Up to two 4th Generation Intel Xeon Scalable Processors and optional Intel ® QuickAssist Technology
- Up to 16 DDR5 DIMM slots
- Two redundant AC or DC power supply units
- PCI Express® (PCIe) 4.0 enabled expansion slots
- Up to 24 x 3.5-inch SAS/SATA + 4 x 3.5-inch SAS/SATA or 4 x 2.5-inch PCIe NVMe with 3.5-inch carrier adapter or 2 x 2.5-inch NVMe SSD
- Network interface technologies to cover Network Interface Card (NIC)

Topics:

- [Key workloads](#)
- [New technologies](#)

Key workloads

Target workloads are:

- File and object storage
- Video capturing & surveillance
- Video streaming

R760xd2 meets dynamic performance and capacity requirements with flexible storage options.

New technologies

Table 1. New technologies

Technology	Detailed Description
Intel Sapphire Rapids Processor (Socket E, LGA-4677)	Core count: Up to 32 core processor
	3 x Intel® Ultra Path Interconnect (UPI) at 16 GT/s
	Maximum number of PCIe lanes: Integrated 80 PCIe lanes @ 16 GT/s PCIe Gen4
	Maximum TDP: 185 W
4800 MT/s DDR5 Memory	Maximum 8 DIMM slots per processor and 16 slots per system
	Supports DDR5 ECC RDIMM up to 4800 MT/s
Flex I/O	LOM board, 2x 1 GB with BCM5720 LAN controller
	Rear I/O with: • 1 GB Dedicated Management Network Port • USB 3.0 x1 • USB 2.0 x1 • VGA port
	OCP 3.0 Mezz (supported by x8 PCIe Gen4 lanes)

Table 1. New technologies (continued)

Technology	Detailed Description
	Front I/O with: • USB 2.0 x1 • Dedicated iDRAC Direct micro-USB x 1
CPLD 1-wire	Support payload data of Riser, BOSS-N1, BP, and Rear I/O to BIOS and iDRAC
Dedicated PERC	PERC 11 and PERC 12
Power Supplies	60 mm dimension is the new PSU form factor design.
	700 W AC/DC HLAC Titanium
	1100 W AC/DC Titanium
	1400 W AC/DC Platinum
	1800 W AC/DC HLAC Titanium
	1100 W DC (-48 V)

System features and generational comparison

The following table shows the comparison between the PowerEdge R760xd2 with the PowerEdge R740xd2.

Table 2. Features comparison

Features	PowerEdge R760xd2	PowerEdge R740xd2
Processors	Up to two 4 th Generation Intel® Xeon® Scalable processors with up to 32 cores per processor. Support for up to 2 x 185W processors	Up to two 2 nd Generation Intel® Xeon® Scalable processors with up to 22 cores per processor. Support for up to 2 x 140W processors
CPU interconnect	Intel® Ultra Path Interconnect (UPI) @ 16 GT/s	Intel® Ultra Path Interconnect (UPI) @ 10.4 GT/s
Memory	Up to 16 x DDR5 RDIMMs DIMM Speed: Up to 4800 MT/s	Up to 16 x DDR4 RDIMMs DIMM Speed: Up to 3200 MT/s
Storage Controllers	PERC 12: H965i PERC 11: HBA355i, H755, H355 External PERC: HBA355e	PERC H740P or HBA330
Drive Bays	Front: Up to 12 x 3.5 inch SAS/SATA Middle: Up to 12 x 3.5 inch SAS/SATA Rear: Up to 4 x 3.5 inch Universal or Up to 2 x 2.5 inch U.2 NVMe	Front: Up to 24 x 3.5 inch SAS/SATA Rear: Up to 2 x 3.5 inch SAS/SATA 3.5 inch or SSD
Power Supplies	15G/16G 60mm PSUs 48Vdc/1100W, 700W, 1100W, 1400W, 1800W	750W, 1100W
Cooling Options	Air cooled	Air cooled
Fans	Up to 6 STD fans	Up to 6 HPR fans
Dimension	H x W x D: 2U x 481.6 mm x 837 mm	H x W x D: 2U x 482 mm x 810.26 mm
Form Factor	2U	2U
Embedded Management	iDRAC9 Enterprise, Datacenter license options; OpenManage Enterprise and Plugins	iDRAC9 Enterprise, Datacenter license options; OpenManage Enterprise and Plugins
OpenManage Software	• OpenManage Enterprise • OpenManage Power Manager plugin • OpenManage Service plugin • OpenManage Update Manager plugin • CloudIQ for PowerEdge plug in • OpenManage Enterprise Integration for VMware vCenter • OpenManage Integration for Microsoft System Center • OpenManage Integration with Windows Admin Center	• OpenManage Enterprise • OpenManage Power Center • OpenManage Mobile
Mobility	OpenManage Mobile	OpenManage Mobile

Table 2. Features comparison (continued)

Features	PowerEdge R760xd2	PowerEdge R740xd2	
Integrations and Connections	OpenManage Integrations • BMC Truesight • Microsoft System Center • OpenManage Integration with ServiceNow • Red Hat Ansible Modules • Terraform Providers • VMware vCenter and vRealize Operations Manager	Integrations: • Microsoft® System Center • VMware® vCenter™ • BMC Truesight • Red Hat Ansible Modules	Connections: • Nagios Core & Nagios XI • Micro Focus Operations Manager i (OMi) • IBM Tivoli Netcool/OMNibus • IBM Tivoli® Network Manager IP Edition
Security	• Cryptographically signed firmware • Data at Rest Encryption (SEDs with local or external key mgmt) • Secure Boot • Secured Component Verification (Hardware integrity check) • Secure Erase • Silicon Root of Trust • System Lockdown (requires iDRAC9 Enterprise or Datacenter) • TPM 2.0 FIPS, CC-TCG certified, TPM 2.0 China NationZ	• TPM 1.2/2.0, TCM 2.0 optional • Cryptographically signed firmware • Silicon Root of Trust • Secure Boot • System Lockdown (requires iDRAC Enterprise or Datacenter)	
Embedded NIC	2 x 1 GbE LOM	2 x 1 GbE LOM	
Networking Options	OCP 3.0 x8 (Optional)	OCP (Optional)	
GPU Options	Up to 2 x 75 W SW , 1 x 75 W SW + 1 x 150 W SW or 1 x 180 W DW	None	
Ports	Front: 1 x USB 2.0, 1x iDRAC Direct (Micro-USB) Rear: 1 x VGA, 1 x USB2.0 + 1 x USB3.0 Internal : USB3.0 (Optional)	Front: 2 x USB 2.0, 1 managed (micro USB) + front VGA Rear: 1 x Gen2 + 1 x Gen3 USB Optional Internal USB	
PCIe	Up to 5 x PCIe Slots Gen4 (mix of LP, HL, FL, DW)	Up to 2 x PCIe Slots Gen3	
Operating System and Hypervisors	• Canonical Ubuntu Server LTS • Microsoft Windows Server with Hyper-V • Red Hat Enterprise Linux • SUSE Linux Enterprise Server • VMware ESXi For specifications and interoperability details, see Dell.com/OSsupport .	• Canonical® Ubuntu® LTS • Citrix® Hypervisor • Microsoft® Windows Server® LTSC with Hyper-V • Oracle® Linux • Red Hat® Enterprise Linux • SUSE® Linux Enterprise Server • VMware® ESXi For specifications and interoperability details, see Dell.com/OSsupport .	

Chassis views and features

Topics:

- Front view of the system
- Rear view of the system
- Inside the system
- Quick Resource Locator

Front view of the system



Figure 1. Front view of 12 x 3.5-inch drive system



Figure 2. Front view of 24 x 3.5-inch drive system

Rear view of the system



Figure 3. 3 x PCIe Low-Profile Slots with 4 x 3.5-inch SAS/SATA or 4 x 2.5-inch NVMe Drives



Figure 4. 2 x PCIe Low-Profile Slots + 4 x 3.5-inch SAS/SATA Drives with 1 CPU



Figure 5. 5 x PCIe Low-Profile Slots



Figure 6. 3 x PCIe Low-Profile Slots with 1 CPU



Figure 7. 5 x PCIe Low-Profile Slots + 2 x 2.5-inch NVMe Drives



Figure 8. 3 x PCIe Low-Profile Slots + 2 x 2.5-inch NVMe Drives with 1 CPU

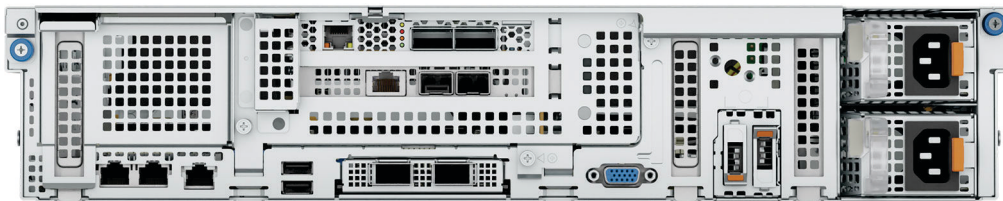


Figure 9. 3 x PCIe Low-Profile Slots + 2 x PCIe FH/FL Slots

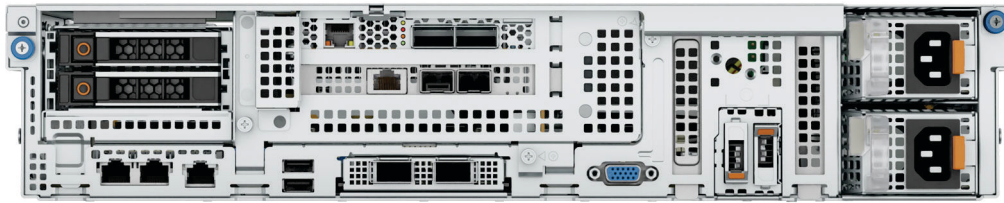


Figure 10. 2 x PCIe Low-Profile Slots + 2 x PCIe x16 FH/FL Slots + 2 x 2.5-inch NVMe Drives

Inside the system

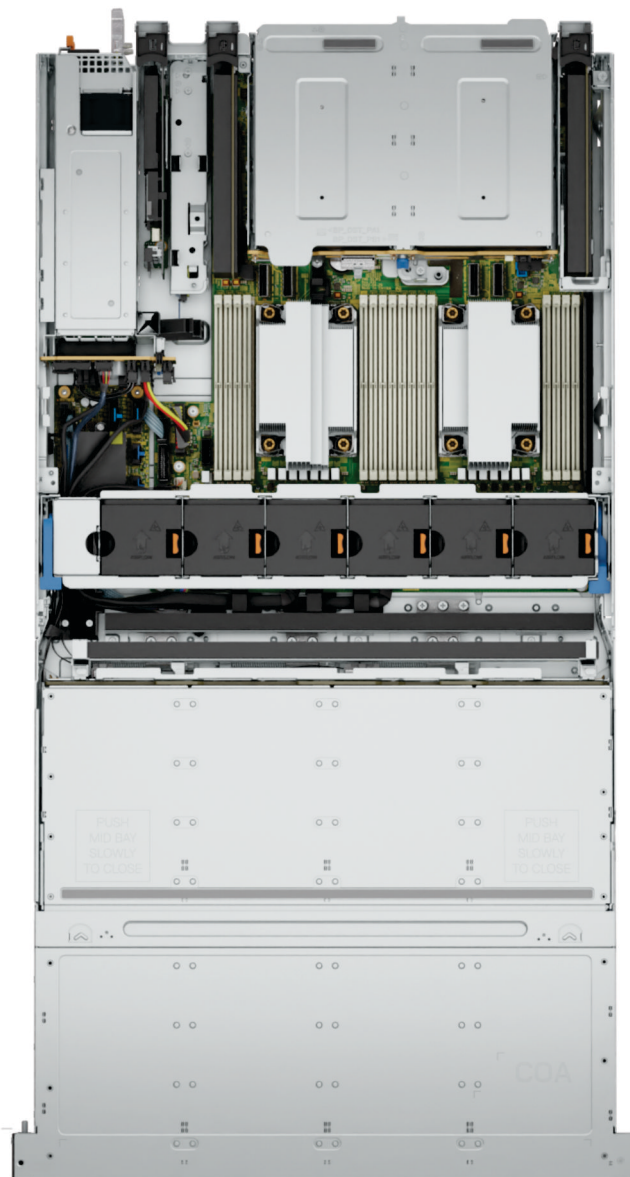


Figure 11. 3 x PCIe Low-Profile Slots with 4 x 3.5-inch SAS/SATA or 4 x 2.5-inch NVMe Drives

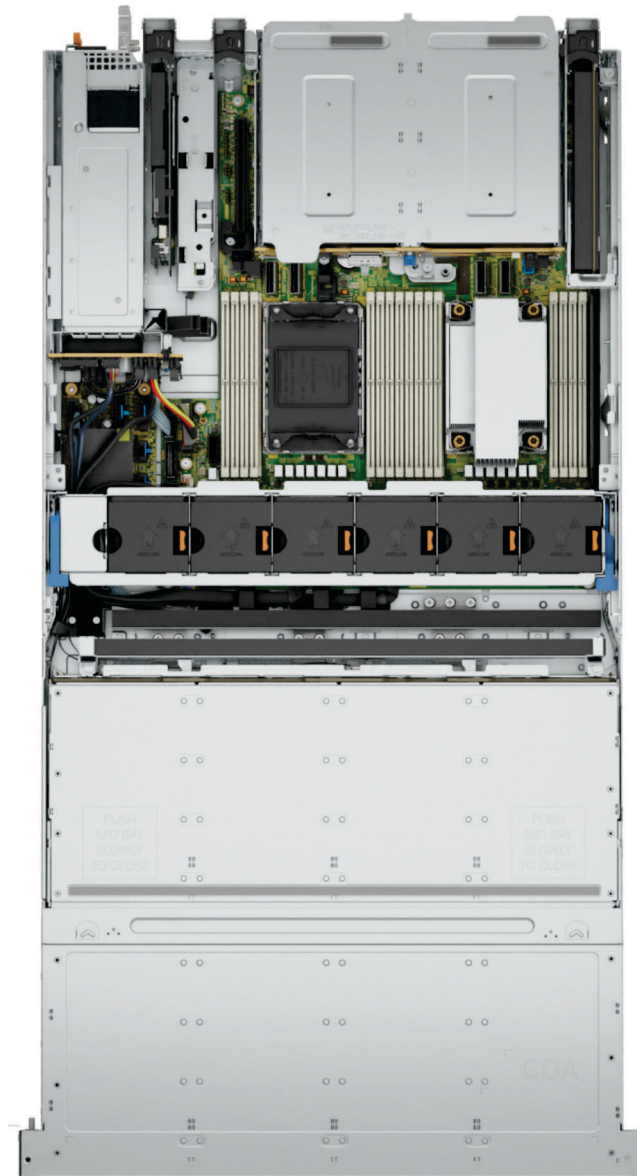


Figure 12. 2 x PCIe Low-Profile Slots + 4 x 3.5-inch SAS/SATA Drives with 1 CPU

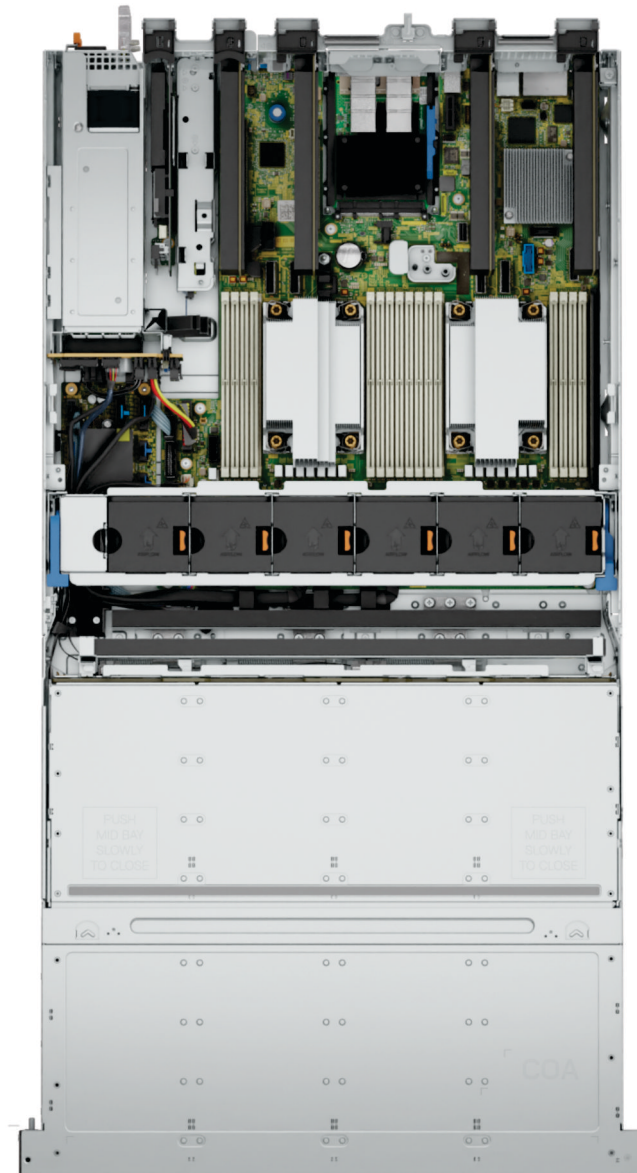


Figure 13. 5 x PCIe Low-Profile Slots

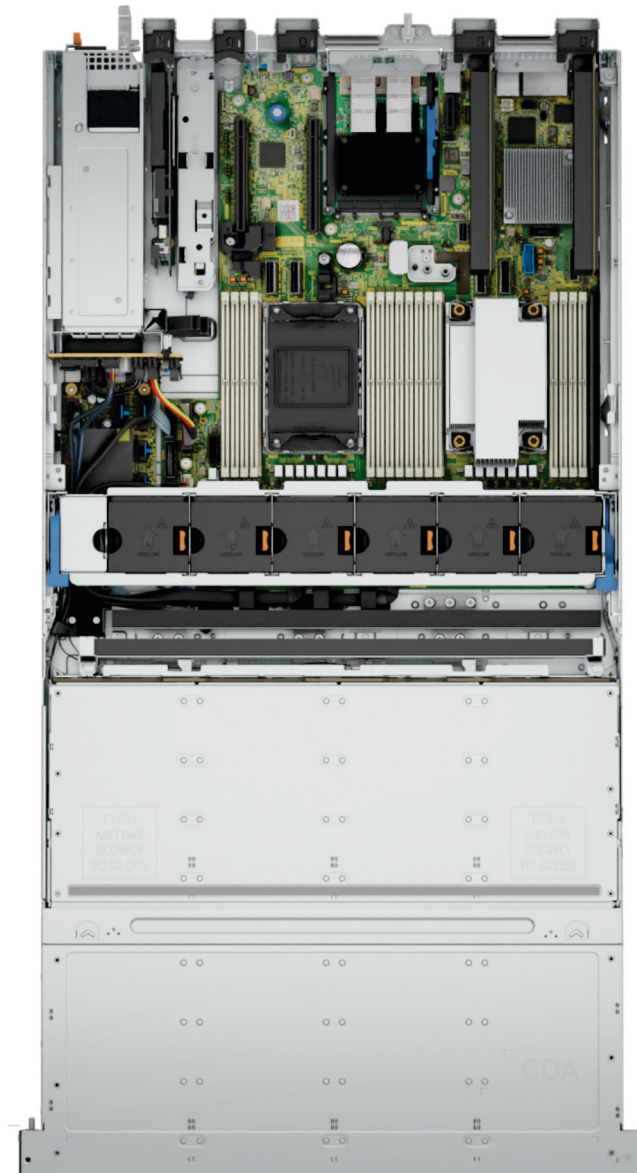


Figure 14. 3 x PCIe Low-Profile Slots with 1 CPU



Figure 15. 5 x PCIe Low-Profile Slots + 2 x 2.5-inch NVMe Drives

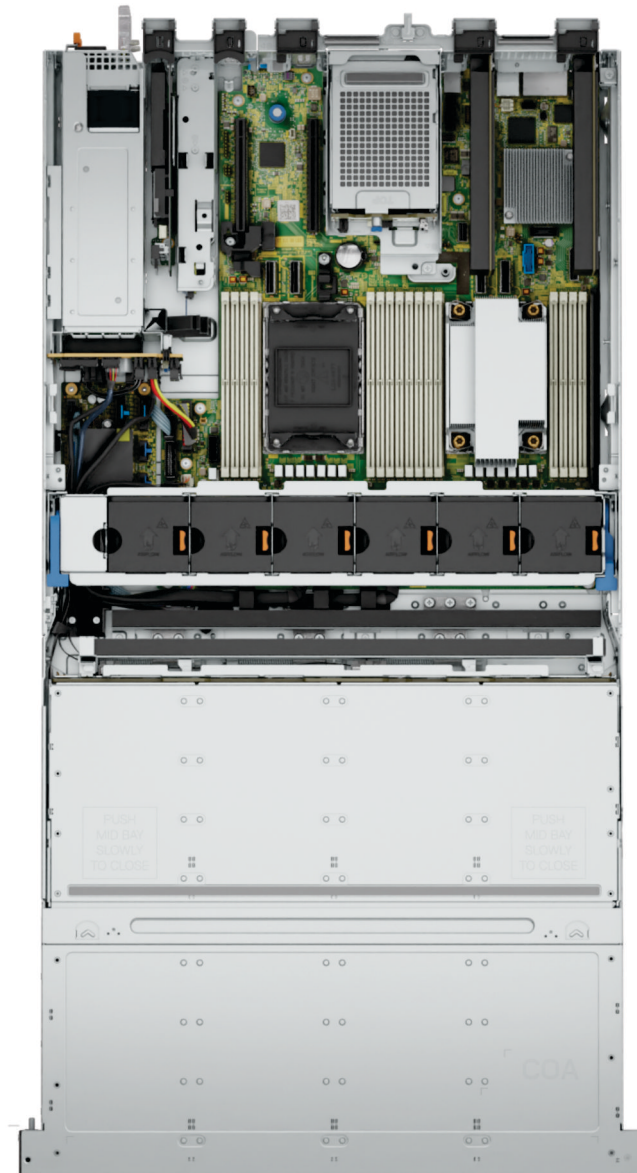


Figure 16. 3 x PCIe Low-Profile Slots + 2 x 2.5-inch NVMe Drives with 1 CPU



Figure 17. 3 x PCIe Low-Profile Slots + 2 x PCIe FH/FL Slots



Figure 18. 2 x PCIe Low-Profile Slots + 2 x PCIe x16 FH/FL Slots + 2 x 2.5-inch NVMe Drives

Quick Resource Locator

The QRL on everything (SILs, GSG, Owner's Manual except on the EST) is a generic QRL for R760xd2 that leads to a webpage for that product. That webpage has links for things like setup and service videos, iDRAC manual, and other things that apply to the platform. The QRL on the EST is unique and specific to that service tag and will contain the Service Tag number and the iDRAC password. The label and the QRL code within it are printed on demand at the L10 factories. This QRL links to a webpage that shows the exact configuration as built for that customer, and the specific warranty purchased. It is one click away from the same content of generic information that applies to R760xd2 that is available in the other QRLs.



Figure 19. Quick Resource Locator for PowerEdgeR760xd2system

Processor

Topics:

- [Processor features](#)

Processor features

The 4th Generation Xeon® Scalable Processors stack is the next generation data center processor offering with significant performance increases, integrated acceleration, and next generation memory and I/O. Sapphire Rapids accelerate customer usages with unique workload optimizations.

The following lists the features and functions that are in the upcoming 4th Generation Intel® Xeon Scalable Processor offering:

- Faster UPI with up to three Intel Ultra Path Interconnect (Intel UPI) at up to 16 GT/s, increasing multisocket bandwidth.
- More, faster I/O with PCI Express Gen4 and up to 80 lanes (per socket)
- Enhanced Memory Performance with DDR5 support and memory speed up to 4800 MT/s in one DIMM per channel (1DPC).
- New built-in accelerators for data analytics, networking, storage, crypto, and data compression

Supported processors

Table 3. Supported processors for R760xd2

Processor	Clock Speed (GHz)	Cache (M)	UPI (GT/s)	Cores	Threads	Turbo	Memory Speed (MT/s)	Memory Capacity	TDP
6428N	1.8	60	16	32	64	Turbo	4800	6TB	185 W
6426Y	2.6	38	16	16	32	Turbo	4800	6TB	185 W
5418Y	2	45	16	24	48	Turbo	4400	6TB	185 W
5418N	1.8	45	16	24	48	Turbo	4400	6TB	165 W
5416S	2	30	16	16	32	Turbo	4400	6TB	150 W
5415+	2.9	23	16	8	16	Turbo	4400	6TB	150 W
5412U	2.1	45	16	24	48	Turbo	4400	6TB	185 W
5411N	1.9	45	16	24	48	Turbo	4400	6TB	165 W
4416+	2	38	16	20	40	Turbo	4000	6TB	165 W
4410Y	2	30	16	12	24	Turbo	4000	6TB	150 W
3408U	1.8	23	16	8	16	No Turbo	4000	6TB	125 W

Memory subsystem

Topics:

- Supported memory

Supported memory

Table 4. Memory technology

Feature	PowerEdge R760xd2 (DDR5)
DIMM type	RDIMM
Transfer speed	4800 MT/s
Voltage	1.1 V

The following table lists the supported DIMMs for R760xd2. For the latest information on supported memory and memory configurations reference the latest SDL.

Table 5. Supported DIMMs

Rated DIMM Speed (MT/s)	DIMM Type	DIMM Capacity (GB)	Ranks per DIMM	Data Width	DIMM Volts
4800	RDIMM	16	1	8	1.1
4800	RDIMM	32	2	8	1.1
4800	RDIMM	64	2	4	1.1

Storage

Topics:

- [Storage controllers](#)
- [Supported Drives](#)
- [Internal storage configuration](#)
- [External Storage](#)

Storage controllers

Dell's RAID controller options offer performance improvements, including the Adapter PERC solution. Adapter PERC provides a base RAID HW controller without consuming a PCIe slot by using a small form factor and high-density connector to the base planar

Table 6. PERC Series controller offerings

Performance Level	Controller and Description
Entry	NA
Value	HBA355i Adapter (Internal)
Value Performance	H755 Adapter, H355 Adapter, H965i Adapter
External Controllers	HBA355e

NOTE: For more information on the features of the Dell PowerEdge RAID controllers (PERC), Software RAID controllers, or BOSS card, and on deploying the cards, see the storage controller documentation at www.dell.com/storagecontrollermanuals.

NOTE: From December 2021, H355 will replace H345 as the entry raid controller. H345 will be deprecated in January 2022.

Storage controller feature matrix

Table 7. Storage controller feature matrix

Model & Form Factors	Interface Support	PCI Support	SAS Connection	Cache Memory Size	Write Back Cache	RAID Levels	Max Drive Support	RAID Support
PowerEdge Server-Storage Controllers (PERC) Series 12								
H965i Adapter	24Gb/s SAS 6Gb/s SAS/SATA Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports/lanes - 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16	Hardware
PowerEdge Server-Storage Controllers (PERC & SAS HBA) Series 11								

Table 7. Storage controller feature matrix (continued)

Model & Form Factors	Interface Support	PCI Support	SAS Connection	Cache Memory Size	Write Back Cache	RAID Levels	Max Drive Support	RAID Support
H755 Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA Gen3 (8 GT/s) NVMe Gen4 (16 GT/s) NVMe	PCIe Gen 4	16 ports- 2x8 Internal	8GB NV	Flash Backed Cache	0,1,5,6,10,50,60	16/ controller 50 with SAS Expander	Hardware
HBA355i Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	N/A	N/A	N/A	16/ controller 50 with SAS Expander	N/A
HBA355e Adapter	12Gb/s SAS 6Gb/s SAS/SATA 3Gb/s SAS/SATA	PCIe Gen 4	16 ports- 4x4 external	N/A	N/A	N/A	240	N/A
H355 Adapter	12Gb/s SAS 6Gb/s SAS/SATA	PCIe Gen 4	16 ports- 2x8 Internal	No Cache	No Cache	0,1, 10	Up to 32 RAID, or 32 Non- RAID	Hardware

NOTE:

1. RAID 5/50 removed from entry RAID card
2. SWRAID support for Linus provides a pre-boot configuration utility to configure MDRAID and degraded boot capability.
3. For information, post-RTS, see the Storage controller documentation at www.dell.com/stroagecontrollermanuals.

This document is updated as changes happen, so for the latest version be sure to bookmark it rather than downloading an offline copy or refer to the [Storage Controller Matrix](#) on sales portal.

Supported Drives

The table shown below lists the internal drives supported by the R760xd2. Refer to Agile for the latest SDL.

Table 8. Supported Drives

Form Factor	Type	Speed	Rotational Speed	Capacities
2.5 inches	NVMe	Gen4	SSD	1.6 TB, 1.92 TB, 3.2 TB, 3.84 TB, 6.4 TB, 7.68 TB, 15.36 TB
	DC NVMe	Gen4	SSD	960 GB, 3.84 TB
	vSAS	12 Gb	SSD	960 Gb, 1.92 TB, 3.84 TB, 7.68 TB
	SAS	24 Gb	SSD	800 Gb, 1.6 TB, 1.92 TB, 3.84 TB, 7.68 TB
	SATA	6 Gb	SSD	480 Gb, 960 Gb, 1.6 TB, 1.92 TB, 3.84 TB, 7.68 TB
	SAS	12 Gb	10 K	600 GB, 1.2 TB, 2.4 TB
3.5 inches	SAS	12 Gb	7.2 K	2 TB, 4 TB, 8 TB, 12 TB, 16 TB, 20 TB, 22 TB
	SATA	6 Gb	7.2 K	2 TB, 4 TB, 8 TB, 12 TB, 16 TB, 20 TB, 22 TB

Internal storage configuration

R760xd2 supports the following internal storage configurations:

- 2 x 12 x 3.5 inch SAS/SATA RAID
- 2 x 12 x 3.5 inch SAS/SATA RAID with rear 4 x 3.5 inch SAS/SATA
- 2 x 12 x 3.5 inch SAS/SATA RAID with rear 4 x 2.5 inch NVMe
- 2 x 12 x 3.5 inch SAS/SATA RAID with rear 2 x U.2 NVMe

External Storage

The R760xd2 support the external storage device types listed in the table below.

Table 9. Supported External Storage Devices

Device Type	Description
External Tape	Supports connection to external USB tape products
NAS/IDM appliance software	Supports NAS software stack
JBOD	Supports connection to 12Gb MD-series JBODs

Networking

Topics:

- [Overview](#)
- [OCP 3.0 support](#)

Overview

PowerEdge offers a wide variety of options to get information moving to and from our servers. Industry best technologies are chosen, and systems management features are added by our partners to firmware to tie in with iDRAC. These adapters are rigorously validated for worry-free, fully supported use in Dell servers.

OCP 3.0 support

Table 10. OCP 3.0 feature list

Feature	OCP 3.0
Form factor	SFF
PCIe Gen	Gen4
Max PCIe width	x8
Max no.of ports	4
Port type	BT/SFP/SFP+/SFP28/SFP56
Max port speed	100 GbE
NC-SI	Yes
SNAPI	Yes
WoL	Yes
Power consumption	15 W - 150 W

Supported OCP cards

Table 11. The below table lists the supported OCP in R760xd2

Form factor	Vendor	Port type	Port speed	Port count
OCP 3.0	Broadcom	BT	1 GbE	4 Port
	Broadcom	BT	1 GbE	4 Port
	Intel	BT	1 GbE	4 Port
	Broadcom	BT	10 GbE	2 Port
	Broadcom	BT	10 GbE	4 Port
	Intel	BT	10 GbE	2 Port

Table 11. The below table lists the supported OCP in R760xd2 (continued)

Form factor	Vendor	Port type	Port speed	Port count
	Intel	BT	10 GbE	4 Port
	Intel	BT	10 GbE	4 Port
	Mellanox	SFP28	25 GbE	2 Port
	Broadcom	SFP28	25 GbE	2 Port
	Broadcom	SFP28	25 GbE	4 Port
	Intel	SFP28	25 GbE	2 Port
	Intel	SFP28	25 GbE	4 Port

OCP NIC 3.0 vs. rack Network Daughter Card comparisons

Table 12. OCP 3.0, 2.0, and rNDC NIC comparison

Form Factor	Dell rNDC	OCP 2.0 (LOM Mezz)	OCP 3.0	Notes
PCIe Gen	Gen 3	Gen 3	Gen 4	Supported OCP3 are SFF (small form factor)
Max PCIe Lanes	x8	Up to x16	Up to x16	See server slot priority matrix
Shared LOM	Yes	Yes	Yes	This is iDRAC port redirect
Aux Power	Yes	Yes	Yes	Used for Shared LOM

OCP form factors

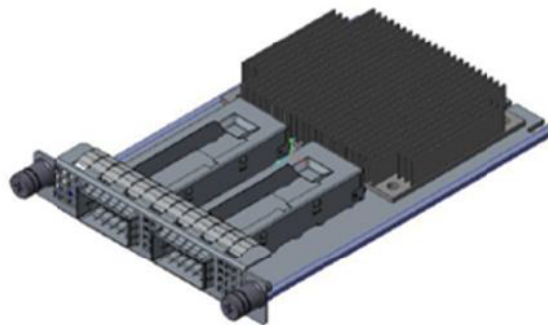


Figure 20. OCP 3.0 Small Card Form Factor (LS)

The process of removing the OCP card in R760xd2 system:

1. Open the blue latch to unlock the OCP card.
2. Push the OCP card towards the rear end of the system to disconnect from the connector on the system board.
3. Slide the OCP card out of the slot on the system.

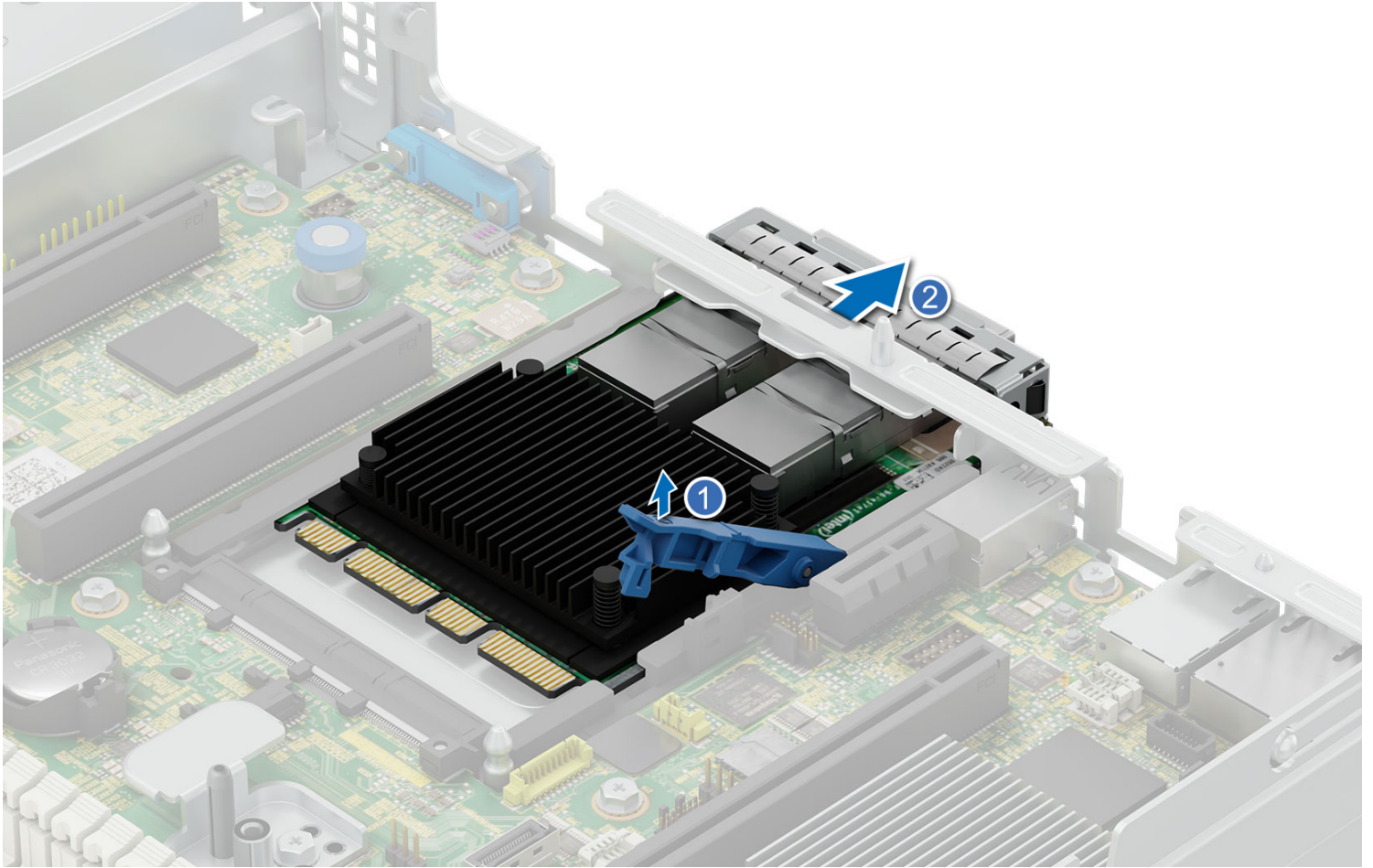


Figure 21. Removing the OCP Card in R760xd2

The process of installing the OCP card in R760xd2 system:

1. Open the blue latch on the system board.
2. Slide the OCP card into the slot in the system.
3. Push until the OCP card is connected to the connector on the system board.
4. Close the latch to lock the OCP card to the system.

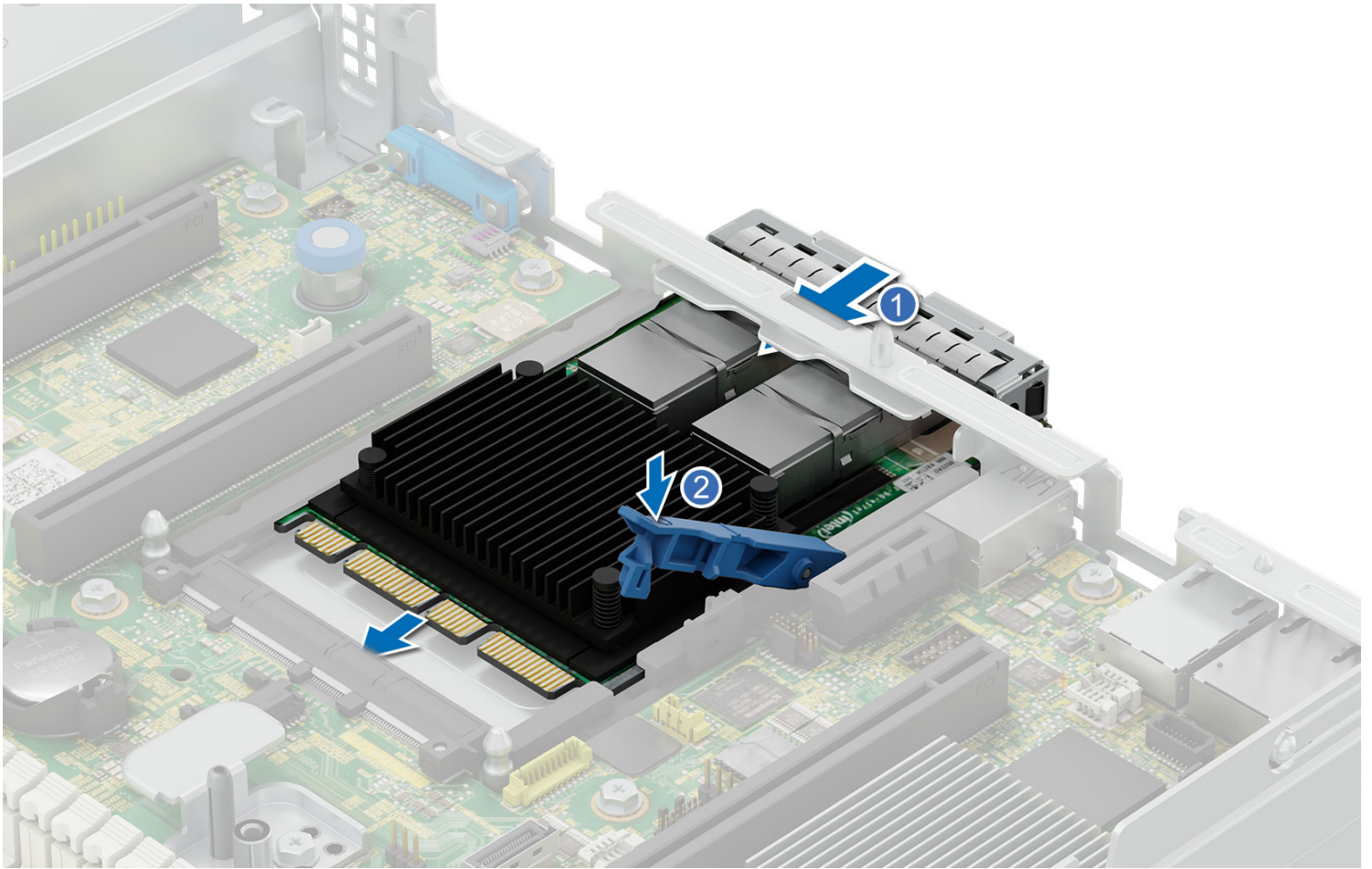


Figure 22. Installing the OCP Card in R760xd2

PCIe subsystem

Topics:

- [PCIe risers](#)

PCIe risers

Shown below are the riser offerings for the platform. For a full list of supported cards and Slot priority, please see the Slot Priority Matrix - found in the Agile tool (P/N:R20W5)

Figure 23. Riser Offerings

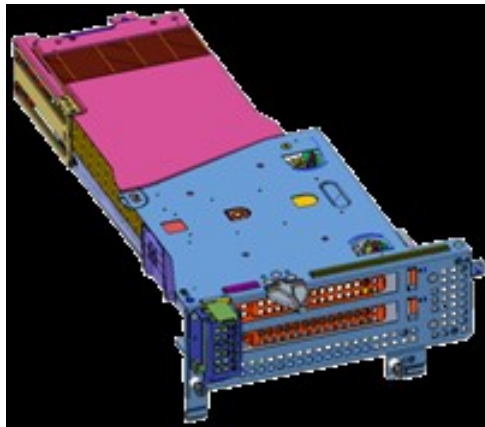


Figure 24. Config 3 FH FL Riser



Figure 25. Config 3 FH HL Riser

Power, thermal, and acoustics

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps to regulate temperature by reducing server noise and power consumption. The table below lists the tools and technologies Dell offers to lower power consumption and increase energy efficiency.

Topics:

- [Power](#)
- [Thermal](#)
- [Acoustics](#)

Power

Table 13. Power tools and technologies

Feature	Description
Power Supply Units(PSU) portfolio	Dell's PSU portfolio includes intelligent features such as dynamically optimizing efficiency while maintaining availability and redundancy. Find additional information in the Power supply units section.
Tools for right sizing	Enterprise Infrastructure Planning Tool (EIPT) is a tool that can help you determine the most efficient configuration possible. With Dell's EIPT, you can calculate the power consumption of your hardware, power infrastructure, and storage at a given workload. Learn more at www.dell.com/calc .
Industry Compliance	Dell's servers are compliant with all relevant industry certifications and guide lines, including 80 PLUS, Climate Savers and ENERGY STAR.
Power monitoring accuracy	PSU power monitoring improvements include: • Dell's power monitoring accuracy is currently 1%, whereas the industry standard is 5% • More accurate reporting of power • Better performance under a power cap
Power capping	Use Dell's systems management to set the power cap limit for your systems to limit the output of a PSU and reduce system power consumption. Dell is the first hardware vendor to leverage Intel Node Manager for circuit-breaker fast capping.
Systems Management	iDRAC Enterprise and Datacenter provides server-level management that monitors, reports and controls power consumption at the processor, memory and system level. Dell OpenManage Power Center delivers group power management at the rack, row, and data center level for servers, power distribution units, and uninterruptible power supplies.
Active power management	Intel Node Manager is an embedded technology that provides individual server-level power reporting and power limiting functionality. Dell offers a complete power management solution comprised of Intel Node Manager accessed through Dell iDRAC9 Datacenter and OpenManage Power Center that allows policy-based management of power and thermal at the individual server, rack, and data center level. Hot spare reduces power consumption of redundant power supplies. Thermal control off a speed optimizes the thermal settings for your environment to reduce fan consumption and lower system power consumption. Idle power enables Dell servers to run as efficiently when idle as when at full workload.
Rack infrastructure	Dell offers some of the industry's highest-efficiency power infrastructure solutions, including:

Table 13. Power tools and technologies (continued)

Feature	Description
	- Power distribution units (PDUs) - Uninterruptible power supplies (UPSs) - Energy Smart containment rack enclosures Find additional information at: https://www.delltechnologies.com/en-us/servers/power-and-cooling.htm.

Power Supply Units

Energy Smart power supplies have intelligent features, such as the ability to dynamically optimize efficiency while maintaining availability and redundancy. Also featured are enhanced power-consumption reduction technologies, such as high-efficiency power conversion and advanced thermal-management techniques, and embedded power-management features, including high-accuracy power monitoring. The table below shows the power supply unit options that are available for the R760xd2.

Table 14. Power Supply Unit Options

Wattage	Frequency	Voltage/Current	Class	Heat dissipation
700 W	50/60 Hz	200-240 Vac/4.1 A	Titanium	2625 BTU/hr
	NA	240 Vdc/3.4 A	NA	
1100 W	50/60 Hz	100-240 Vac/12-3.6 A	Titanium	4125 BTU/hr
	NA	240 Vdc/5.2 A	NA	
1400 W	50/60 Hz	100-240 Vac/12-8 A	Platinum	5250 BTU/hr
	NA	240 Vdc/6.6 A	NA	
1800 W	50/60 Hz	200-240 Vac/10 A	Titanium	6610 BTU/hr
	NA	240 Vdc/8.2 A	NA	
1100 W DC	NA	(-48) — (-60) Vdc/ 27 A	NA	4265 BTU/hr

NOTE: If a system with AC 1100W or 1400W PSUs operate at low line 100 ~ 120 Vac, then the power rating per PSU is de-rated to 1050W.

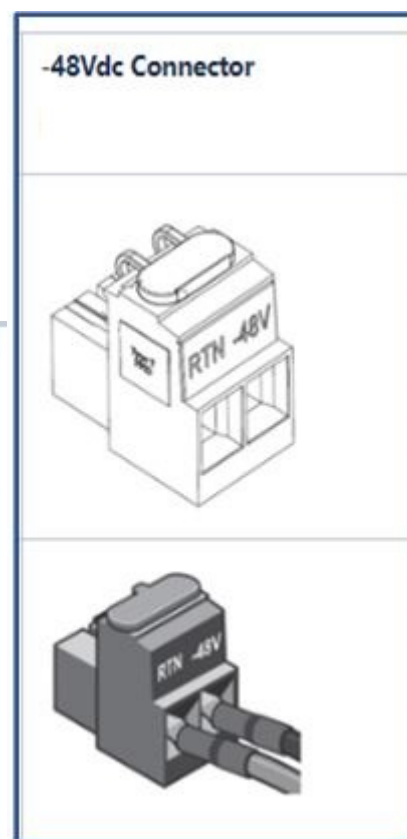
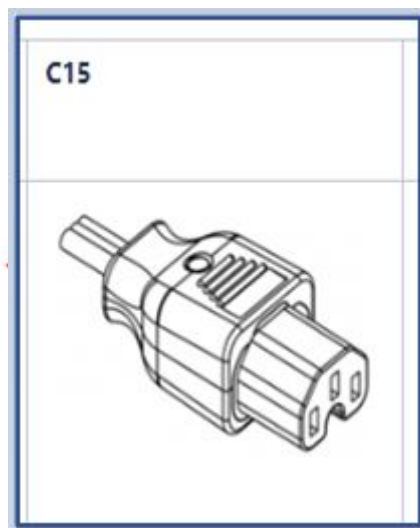


Figure 26. PSU power cord

Table 15. PSU power cords

Form factor	Output	Power cord
Redundant 60 mm	700 W	C13
	1100 W	
	1400 W	
	1100 W DC	-48Vdc connector.
	1800 W	C15

Thermal

PowerEdge servers have an extensive collection of sensors that automatically track thermal activity, which helps regulate temperature thereby reducing server noise and power consumption.

Thermal design

Thermal management of the platform helps deliver high performance with the right amount of cooling to components, while maintaining the lowest fan speeds possible. This is done across a wide range of ambient temperatures from 10°C to 35°C (50°F to 95°F) and to extended ambient temperature ranges.

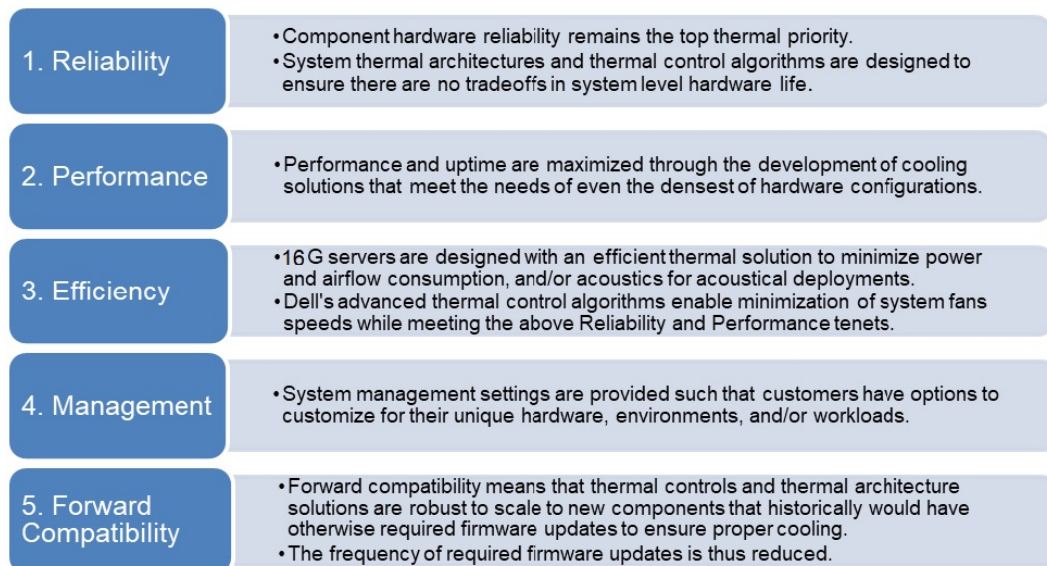


Figure 27. Thermal design characteristics

The thermal design of the PowerEdge R760xd2 reflects the following:

- Optimized thermal design: The system layout is architected for optimum thermal design.
- System component placement and layout are designed to provide maximum airflow coverage to critical components with minimum expense of fan power.
- Comprehensive thermal management: The thermal control system regulates the fan speed based on several different responses from all system-component temperature sensors, and inventory for system configurations. Temperature monitoring includes components such as processors, DIMMs, chipset, the inlet air ambient, hard disk drives, and OCP.
- Open and closed loop thermal fan speed control: Open loop thermal control uses system configuration to determine fan speed based on inlet air ambient temperature. Closed loop thermal control method uses feedback temperatures to dynamically determine proper fan speeds.
- User-configurable settings: With the understanding and realization that every customer has unique set of circumstances or expectations from the system, in this generation of servers, we have introduced limited user- configurable settings residing in the iDRAC BIOS setup screen. For more information, see the Dell PowerEdge R760 Installation and Service Manual at www.dell.com/poweredgemanuals and “Advanced Thermal Control: Optimizing across Environments and Power Goals” on Dell.com.
- Cooling redundancy: The R760 allows N+1 fan redundancy, allowing continuous operation with one fan failure in the system.
- Environmental Specifications: The optimized thermal management makes the R760 reliable under a wide range of operating environments.

Acoustics

Acoustical performance

Dell EMC PowerEdge R760xd2 is a rack server appropriate for attended data center environment. However, lower acoustical output is attainable with proper hardware or software configurations.

Table 16. Hardware and software configurations for lower acoustical output

Configuration	Quietest	Quietest GPU	Hadoop	SDS typical	SDS + acceleration
Processor Type	Intel Xeon Scalable processor	Intel Xeon Scalable processor	Intel Xeon Scalable processor	Intel Xeon Scalable processor	Intel Xeon Scalable processor
Processor TDP	185 W	185 W	185 W	150 W	185 W
Processor Quantity	1	2	2	2	2
RDIMM Memory	16 GB DDR5	16 GB DDR5	16 GB DDR5	8 GB DDR5	16 GB DDR5

Table 16. Hardware and software configurations for lower acoustical output (continued)

Configuration	Quietest	Quietest GPU	Hadoop	SDS typical	SDS + acceleration
Memory Quantity	2	2	16	8	16
Backplane Type	12 x 3.5-inch BP	12 x 3.5-inch BP	12 x 3.5-inch + 12 x 3.5-inch + Rear SSD x 2	12 x 3.5-inch + 12 x 3.5-inch + Rear 4 x 3.5 inch	12 x 3.5-inch + 12 x 3.5-inch
HDD Type	12 x 3.5 inch 8TB	12 x 3.5 inch 8TB	14 x 3.5 inch front 8 TB, 2 x 2.5 inch rear SSD	28 x 3.5 inch front 16 TB	24 x 3.5 inch 8 TB
HDD Quantity	12	12	14 + 2	28	24
Flash Drives	N/A	N/A	PCIe SSD	N/A	N/A
Flash Quantity	N/A	N/A	2	N/A	N/A
PSU Type	1100 W	1100 W	1100 W	1100 W	1100 W
PSU Quantity	2	2	2	2	2
OCP	N/A	N/A	Dual Port 10/25GbE	Dual Port 10/25GbE	Dual Port 10/25GbE
PCI 1	Intel 10 GbE	Intel 10 GbE	Intel 25 GbE	Intel 10 GbE	Intel 25 GbE
PCI 2	N/A	N/A	N/A	N/A	N/A
PCI 3	N/A	A30 GPU	N/A	H755	A30 GPU
PCI 4	N/A	HBA 355	HBA 355	HBA 355	PERC 965
PCI 5	HBA 355	N/A	N/A	N/A	N/A

Table 17. Acoustical performance of R760xd2 acoustical configurations

Configuration		Quietest	Quietest GPU	Hadoop	SDS typical	SDS + acceleration
Acoustical Performance: Idle/ Operating @ 25 °C Ambient						
L _{wA,m} (B)	Idle	5.0	6.9	6.6	6.6	7.1
	Operating	5.2	7.3	6.6	6.6	7.5
K _v (B)	Idle	0.4	0.4	0.4	0.4	0.4
	Operating	0.4	0.4	0.4	0.4	0.4
L _{pA,m} (dB)	Idle	35	54	51	51	56
	Operating	37	58	51	51	60
Prominent tones		No prominent tones in Idle and Operating				
Acoustical Performance: Idle @ 28 °C Ambient						
L _{wA,m} (B)		5.8	7.2	7.0	7.0	7.4
K _v (B)		0.4	0.4	0.4	0.4	0.4
L _{pA,m} (dB)		42	58	54	55	59
Acoustical Performance: Max. Loading @ 35 °C Ambient						
L _{wA,m} (B)		7.7	8.1	7.6	8.1	8.1
K _v (B)		0.4	0.4	0.4	0.4	0.4
L _{pA,m} (dB)		60	66	60	66	66

LwA,m: The declared mean A-weighted sound power level (LwA) is calculated per section 5.2 of ISO 9296 (2017) with data collected using the methods described in ISO 7779 (2010). Data presented here may not be fully compliant with ISO 7779.

LpA,m: The declared mean A-weighted emission sound pressure level is at the bystander position per section 5.3 of ISO 9296 (2017) and measured using methods described in ISO 7779 (2010). The system is placed on standard test table and in a 24U rack enclosure, 25cm above a reflective floor. Data presented here may not be fully compliant with ISO 7779.

Prominent discrete tones: Criteria of Annex D of ECMA-74 & Prominence Ratio method of ECMA-418 are followed to determine if discrete tones are prominent and to report them, if so..

Idle mode: The steady-state condition in which the server is energized but not operating any intended function.

Operating mode: Operating mode is represented by the maximum of the steady state acoustical output at 50% of CPU TDP or active storage drives for the respective sections of Annex C of ECMA-74.

Customer Usage Operating mode: The operating mode is represented by the maximum of the steady state acoustical output at 0%~40% of CPU TDP, 5%~50% IOPs load, 0%~20% Memory load, and 10 0% GPU load as the components showed in the above configurations

PowerEdge acoustical specifications

For more information on acoustical specifications, see ENG0019663. (See the category definitions.)

Dell typically categorizes servers in five categories of acoustically acceptable usage:

- Category 1: Table-top in Office Environment
- Category 2: Floor-standing in Office Environment
- Category 3: General Use Space
- Category 4: Attended Data Center
- Category 5: Unattended Data Center

Category 1: Floor-standing in Office Environment

When Dell determines that a specific Enterprise product is to be used on a table-top in office environment, for example, on a desk around a seated user's head height, then the acoustical specification of the following table applies. Small, light-weight towers are examples of these types of products.

Table 18. Dell Enterprise Category 1, "Table-top in Office Environment" acoustical specification category.

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program's configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient
Sound Power	LWA,m, B	≤ 4.2	≤ 4.7	≤ 5.0	Report
Sound Quality (both positions must meet limits): Front Binaural HEAD and Rear Microphone	Tones, Hz, dB	No prominent tones per criteria D.10.6 and D.10.8 of ECMA-74			Report tones
	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report
	Dell Modulation, %	≤ 35	≤ 35	≤ 35	Report
	Loudness, sones	Report	Report	Report	Report

Table 18. Dell Enterprise Category 1, “Table-top in Office Environment” acoustical specification category. (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient
	LpA-single point, dBA	Report	Report	Report	Report
Front Binaural HEAD	Transients	- Oscillation (see AC0159), if observed, during 20-minute steady-state observation, must adhere to the following two criteria: - Max. {ΔLpA} < 3.0 dB - Event count < 3 for “1.5 dB < ΔLpA < 3.0 dB” - Acoustical Jump (see AC0159), during air mover speed transition from Idle to Operating Mode must be ≤ 15 dB. - Startup behavior - Report Startup behavior re. AC0159 - Startup must proceed smoothly, that is, no sudden or large jumps, and fan speed during startup must not exceed 50% of its maximum - Transient inputs: Report time-history sound pressure levels re AC0159 “Train of Step Functions on Processor”			N/A
Any	Other	No rattles, squeaks, or unexpected noises Sound should be “even” around the EUT (one side should not be dramatically louder than another) Unless otherwise specified, the “default” thermal-related settings shall be selected for BIOS and iDRAC. Specific operating conditions will be defined in “Configurations & Configuration Dependencies” for each platform.			
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Category 2: Floor-standing in Office Environment

When Dell determines that a specific Enterprise product is to be used primarily when it is sitting on the floor, that is, next to a user’s feet, then the acoustical specification in the table below applies. Noise from the product should not annoy or otherwise interfere with the user’s thoughts or speech, for example, on the telephone.

Table 19. Dell Enterprise Category 2, “Floor-standing in Office Environment” acoustical specification category

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient, and for 100% loading and maximum configuration, at 35° C Ambient
Sound Power	LWA,m, B	≤ 4.9	≤ 5.1	≤ 5.4	Report
Sound Quality (both positions must meet limits): Front Binaural HEAD and Rear Microphone	Tones, Hz, dB	No prominent tones per criteria D.10.6 and D.10.8 of ECMA-74			Report tones
	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report
	Dell Modulation, %	≤ 35	≤ 35	≤ 35	Report
	Loudness, sones	Report	Report	Report	Report
	LpA-single point, dBA	Report	Report	Report	Report
Front Binaural HEAD	Transients	- Oscillation (see AC0159), if observed, during 20-minute steady-state observation, must adhere to the following two criteria: - Max. {ΔLpA} < 3.0 dB - Event count < 3 for “1.5 dB < ΔLpA < 3.0 dB” - Acoustical Jump (see AC0159), during air mover speed transition from Idle to Operating Mode must be ≤ 15 dB. - Startup behavior - Report Startup behavior re. AC0159 - Startup must proceed smoothly, that is, no sudden or large jumps, and fan speed during startup must not exceed 50% of its maximum - Transient inputs: Report time-history sound pressure levels re AC0159 “Train of Step Functions on Processor”			N/A
Any	Other	- No rattles, squeaks, or unexpected noises - Sound should be “even” around the EUT (one side should not be dramatically louder than another) - Unless otherwise specified, the “default” thermal-related settings shall be selected for BIOS and iDRAC. - Specific operating conditions are defined in “Configurations and Configuration Dependencies” for each platform.			
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Category 3: General Use Space

When Dell determines that a specific Enterprise product is to be predominantly used in a general use space, then the acoustical specification of the table below applies. These products could be found in laboratories, schools, restaurants, open office space layouts, small ventilated closets, etc., though not in close proximity to any particular person nor in quantities greater than a few in any location. People within proximity of a few of these products should not experience any impact to speech intelligibility or annoyance from the noise of the product. A rack product sitting on a table in a common area is an example.

Table 20. Dell Enterprise Category 3, “General Use” acoustical specification category

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient and for 100% loading and maximum configuration, at 35° C Ambient
Sound Power	LWA,m, B	≤ 5.2	≤ 5.5	≤ 5.8	Report
Sound Quality (both positions must meet limits): Front Binaural HEAD and Rear Microphone	Tones, Hz, dB	No prominent tones per criteria D.10.6 and D.10.8 of ECMA-74			Report tones
	Tonality, tu	≤ 0.35	≤ 0.35	≤ 0.35	Report
	Dell Modulation, %	≤ 40	≤ 40	≤ 40	Report
	Loudness, sones	Report	Report	Report	Report
	LpA-single point, dBA	Report	Report	Report	Report
Front Binaural HEAD	Transients	- Oscillation (see AC0159), if observed, during 20-minute steady-state observation, must adhere to the following two criteria: - Max. {ΔLpA} < 3.0 dB - Event count < 3 for “1.5 dB < ΔLpA < 3.0 dB” - Acoustical Jump (see AC0159), during air mover speed transition from Idle to Operating Mode must be ≤ 15dB. - Startup behavior - Report Startup behavior re. AC0159 - Startup must proceed smoothly, that is, no sudden or large jumps, and air mover speed during startup must not exceed 50% of its maximum - Transient inputs: Report time-history sound pressure levels re AC0159 “Train of Step Functions on Processor”			N/A
Any	Other	No rattles, squeaks, or unexpected noises Sound should be “even” around the EUT (one side should not be dramatically louder than another) Unless otherwise specified, the “default” thermal-related settings shall be selected for BIOS and iDRAC.			

Table 20. Dell Enterprise Category 3, “General Use” acoustical specification category (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)			
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient and for 100% loading and maximum configuration, at 35° C Ambient
		Specific operating conditions will be defined in “Configurations & Configuration Dependencies” for each platform.			
Sound Pressure	LpA-reported, dBA, re AC0158 and program configuration document	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Category 4: Attended Data Center

When Dell determines that a specific Enterprise product is to be predominantly used in an attended data center, then the acoustical specification of the table applies. The phrase “attended data center” is used to mean a space in which many (from tens to 1000s) of Enterprise products are deployed in proximity (that is, in the same room) to personnel whose speech (perhaps with raised voices) is expected to be intelligible over the data center noise. Hearing protection or hearing monitoring programs are not expected in these areas. Examples in this category include monolithic rack products. When Dell determines that a specific Enterprise product is to be predominantly used in a general use space, then the acoustical specification of the above table applies. These products could be found in laboratories, schools, restaurants, open office space layouts, small ventilated closets, etc., though not in close proximity to any particular person nor in quantities greater than a few in any location. People within proximity of a few of these products should not experience any impact to speech intelligibility or annoyance from the noise of the product. A rack product sitting on a table in a common area is an example.

Table 21. Dell Enterprise Category 4, “Attended Data Center” acoustical specification category.

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				Simulate (that is, set fan speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient	
Sound Power	LWA,m, B	Report	≤ 6.9	≤ 7.1	Report	Report
Front Binaural HEAD	Tones, Hz, dB	Report	< 15 dB	< 15 dB	Report	Report
	Tonality, tu	Report	Report	Report	Report	Report
	Dell Modulation, %	Report	Report	Report	Report	Report
	Loudness, sones	Report	Report	Report	Report	Report

Table 21. Dell Enterprise Category 4, “Attended Data Center” acoustical specification category. (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				Simulate (that is, set fan speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set fan speeds representative) for Idle at 28° C & 35° C Ambient	
	LpA-single point, dBA	Report	Report	Report	Report	Report
	Transients	- Oscillation (see AC0159), if observed, during 20-minute steady-state observation, must adhere to the following two criteria: - Max. {ΔLpA} < 3.0 dB - Event count < 3 for “1.5 dB < ΔLpA < 3.0 dB” - Acoustical Jump (see AC0159), during air mover speed transition from Idle to Operating Mode must be ≤ 15 dB. - Startup behavior - Report Startup behavior re. AC0159 - Startup must proceed smoothly, that is, no sudden or large jumps. ∞ Transient inputs: Report time-history sound pressure levels re AC0159 “Train of Step Functions on Processor”			N/A	
Any	Other	No rattles, squeaks, or unexpected noises Sound should be “even” around the EUT (one side should not be dramatically louder than another) Unless otherwise specified, the “default” thermal-related settings shall be selected for BIOS and iDRAC. Specific operating conditions will be defined in “Configurations & Configuration Dependencies” for each platform.				
Sound Pressure	LpA-reported, dBA	Report for all mics	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Category 5: Unattended Data Center

When Dell determines that a specific Enterprise product is to be predominantly used in an unattended data center (and not blades or blade enclosures; these have their own category), then the acoustical specification in the table below applies. The phrase “unattended data center” is used to mean a space in which many (from tens to 1000s) of Enterprise products are deployed together, its own heating and cooling systems condition the space, and operators or servicers of equipment enter generally only to deploy, service, or decommission equipment. Hearing protection or hearing monitoring programs may be expected (per government or company guidelines) in these areas. Examples in this category include monolithic rack products.

Table 22. Dell Enterprise Category 5, “Unattended Data Center” acoustical specification category

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				Simulate (that is, set air mover speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient	
Sound Power	LWA,m, B	Report	≤ 7.5	≤ 7.7	Report	Report
Front Binaural HEAD	Tones, Hz, dB	Report	< 15 dB	< 15 dB	Report	Report
	Tonality, tu	Report	Report	Report	Report	Report
	Dell Modulation, %	Report	Report	Report	Report	Report
	Loudness, sones	Report	Report	Report	Report	Report
	LpA-single point, dBA	Report	Report	Report	Report	Report
Front Binaural HEAD	Transients	• Oscillation (see AC0159), if observed, during 20-minute steady-state observation, must adhere to the following two criteria: ◦ Max. {ΔLpA} < 3.0 dB ◦ Event count < 3 for “1.5 dB < ΔLpA < 3.0 dB” • Report Acoustical Jump (see AC0159) during air mover speed transition from Idle to Operating Mode. • Startup behavior ◦ Report Startup behavior re. AC0159 ◦ Startup must proceed smoothly, that is, no sudden or large jumps. • Transient inputs: Report time-history sound pressure levels re AC0159 “Train of Step Functions on Processor”			N/A	
Any	Other	No rattles, squeaks, or unexpected noises Sound should be “even” around the EUT (one side should not be dramatically louder than another) Unless otherwise specified, the “default” thermal-related settings shall be selected for BIOS and iDRAC. Specific operating conditions will be defined in “Configurations & Configuration Dependencies” for each platform.				
Sound Pressure	LpA-reported, dBA, re	Report for all mics	Report for all mics	Report for all mics	Report for all mics	Report for all mics

Table 22. Dell Enterprise Category 5, “Unattended Data Center” acoustical specification category (continued)

Measurement Position re AC0158	Metric, re AC0159	Test Modes, re AC0159 (note must be in steady state, see AC0159, except where noted below)				Simulate (that is, set air mover speeds representative) for 100% loading and maximum configuration, at 35° C Ambient
		Standby in 23±2° C Ambient	Idle in 23±2° C Ambient	Operating in 23±2° C Ambient – if not otherwise specified in the program’s configuration document, then processor and hard drive operating modes are required	Simulate (that is, set air mover speeds representative) for Idle at 28° C & 35° C Ambient	
	AC0158 and program configuration document					

Rack, rails, and cable management

Topics:

- [Rails and cable management information](#)

Rails and cable management information

The rail offerings for the PowerEdge R760xd2 consist of general type: Stab-in sliding. The cable management offerings consist of an optional cable management arm (CMA) and an optional strain relief bar (SRB).

See the *Enterprise Systems Rail Sizing and Rack Compatibility Matrix* available at https://i.dell.com/sites/csdocuments/Business_solutions_engineering-Docs_Documents/en/rail-rack-matrix.pdf for information regarding:

- Specific details about rail types.
- Rail adjustability ranges for various rack mounting flange types.
- Rail depth with and without cable management accessories.
- Rack types that are supported for various rack mounting flange types.

Key factors governing proper rail selection include the following:

- Spacing between the front and rear mounting flanges of the rack.
- Type and location of any equipment that is mounted in the back of the rack such as power distribution units (PDUs).
- Overall depth of the rack.

Stab-in sliding rails features summary

The stab-in sliding rails allow the system to be partially extended out of the rack for service. The R760xd2 supports Stab-in sliding rails. The stab-in sliding rails are available with or without the optional cable management arm (CMA) or strain relief bar (SRB).

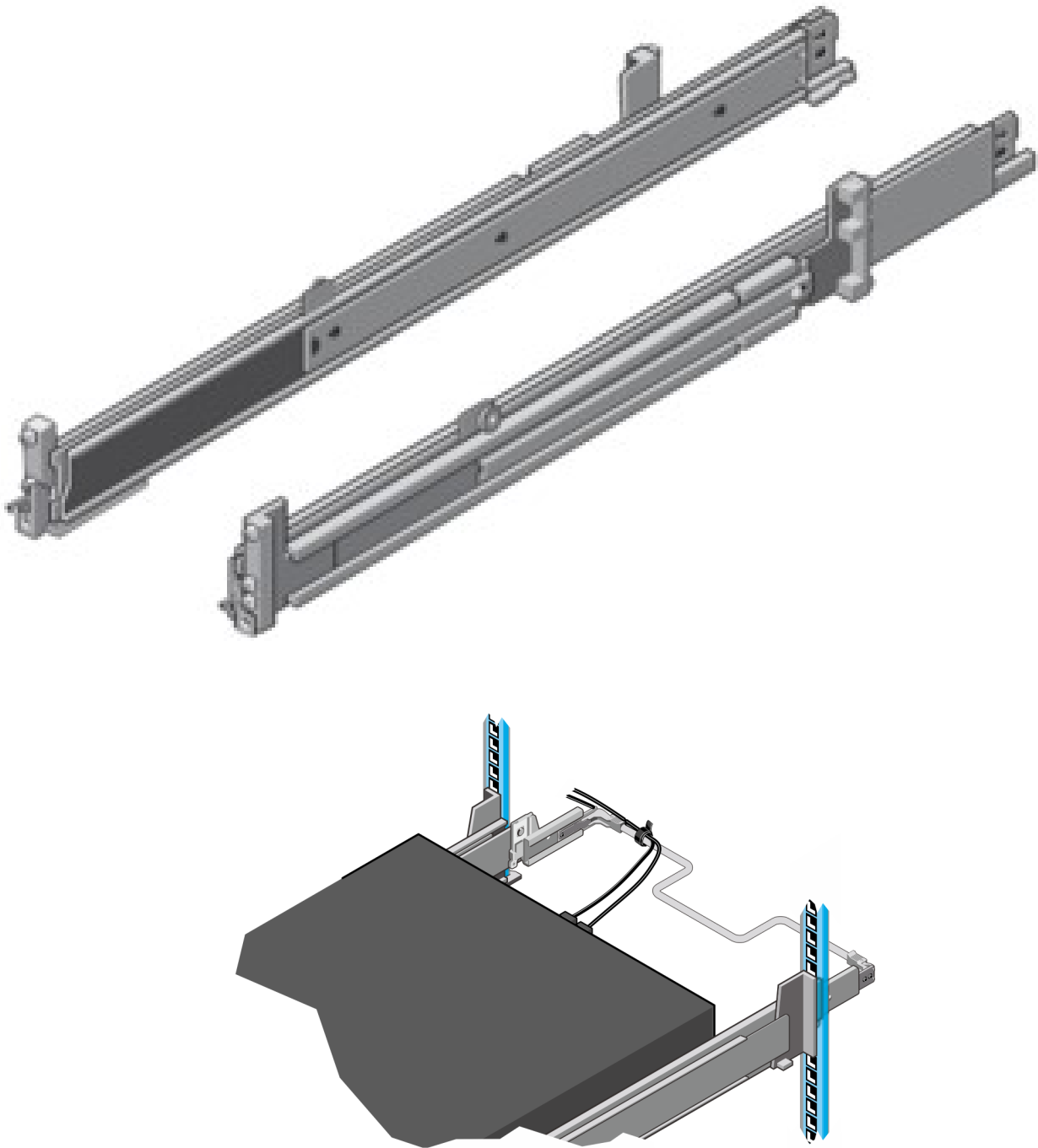


Figure 28. Stab-in sliding rails with optional SRB

B22 Stab-in sliding rails for 4-post racks

- Supports stab-in installation of the chassis to the rails.
- Support for tool-less installation in 19" EIA-310-E compliant square, unthreaded round hole racks including all generations of the Dell racks. Also supports tool-less installation in threaded round hole 4-post racks.
- Support for tool-less installation in Dell Titan or Titan-D racks.
- Support partial extension of the system out of the rack to allow serviceability of key internal components.
- Support for optional cable management arm (CMA).
- Support for optional strain relief bar (SRB).

NOTE: For situations where CMA support is not required, the outer CMA mounting brackets can be uninstalled from the stab-in sliding rails. This reduces the overall length of the rails and eliminates the potential interferences with rear-mounted PDUs or the rear rack door.

Cable management arm (CMA)

The optional cable management arm (CMA) organizes and secures the cords and cables exiting the back of the systems. It unfolds to allow the systems to extend out of the rack without having to detach the cables. Some key features of the CMA include:

- Large U-shaped baskets to support dense cable loads.
- Open vent pattern for optimal airflow.
- Ability to mount on either side by swinging the spring-loaded brackets from one side to the other.
- Utilizes hook-and-loop straps rather than plastic tie wraps to eliminate the risk of cable damage during cycling.
- Includes a low-profile fixed tray to both support and retain the CMA in its fully closed position.
- Both the CMA and the tray mount without the use of tools by simple and intuitive snap-in designs.

NOTE: CMA is not supported in Direct Liquid Cooling configuration.

The CMA can be mounted to either side of the sliding rails without the use of tools or the need for conversion. For systems with one power supply unit (PSU), it is recommended to mount on the side opposite to that of the power supply to allow easier access to it and the rear drives (if applicable) for service or replacement.

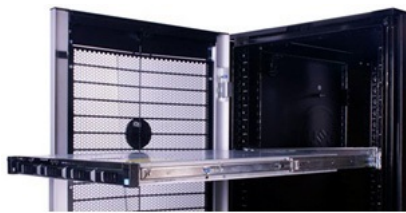


Figure 29. Sliding rails with CMA

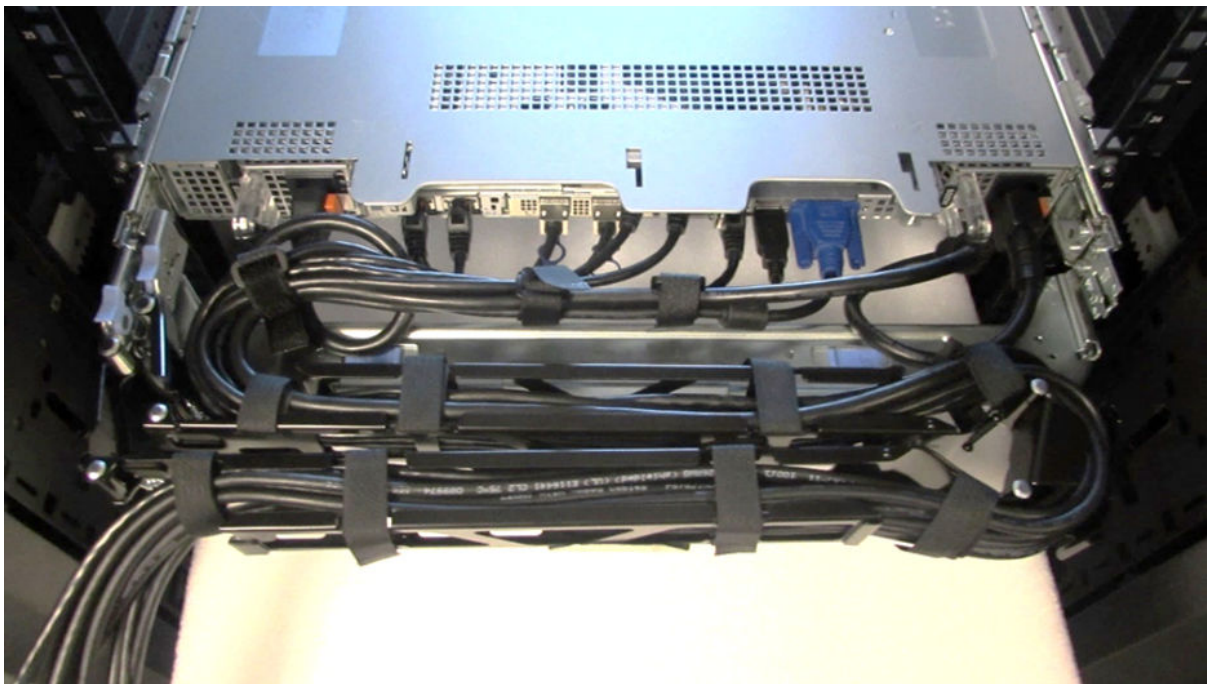


Figure 30. CMA Cabling

Strain Relief Bar (SRB)

The optional strain relief bar (SRB) for the PowerEdge R760xd2 organizes and supports cable connections at the rear end of the server to avoid damage from bending.

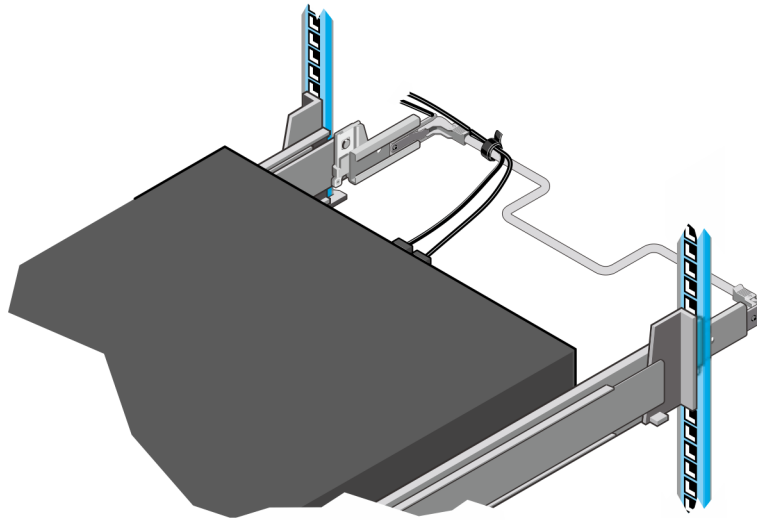


Figure 31. Cabled strain relief bar

- Tool-less attachment to the rails
- Two depth positions to accommodate various cable loads and rack depths
- Supports cable loads and controls stresses on server connectors
- Cables can be segregated into discrete purpose-specific bundles

Rack Installation

Stab-in design means that the inner (chassis) rail members must first be attached to the sides of the system and then inserted into the outer (cabinet) members installed in the rack.

Installing the system into the rack : Stab-In

1. Pull the intermediate rails out of the rack until they lock into place.
2. Release the inner rail lock by pulling forward on the white tabs and sliding the inner rail out of the intermediate rails.

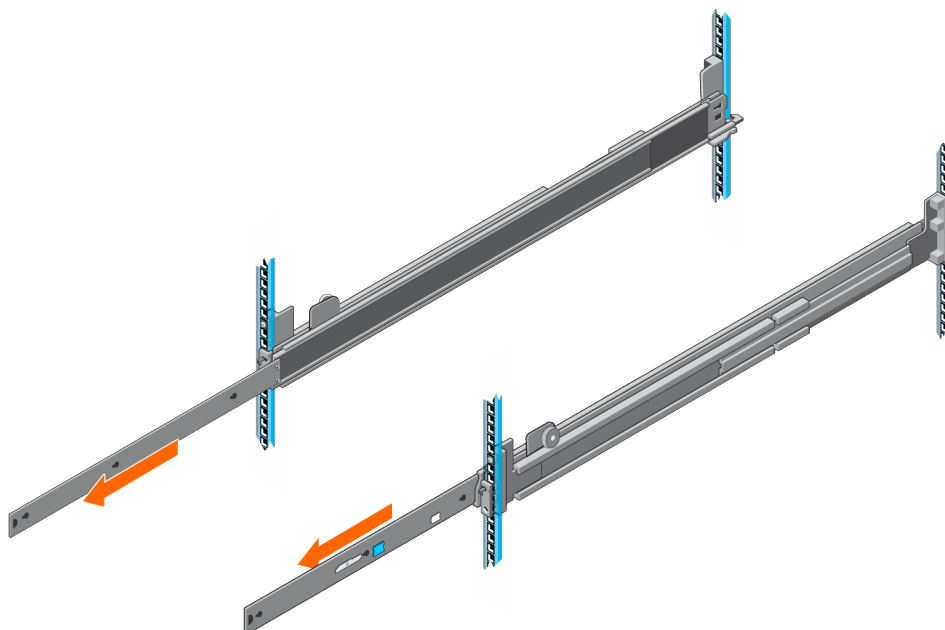


Figure 32. Pull out the intermediate rail

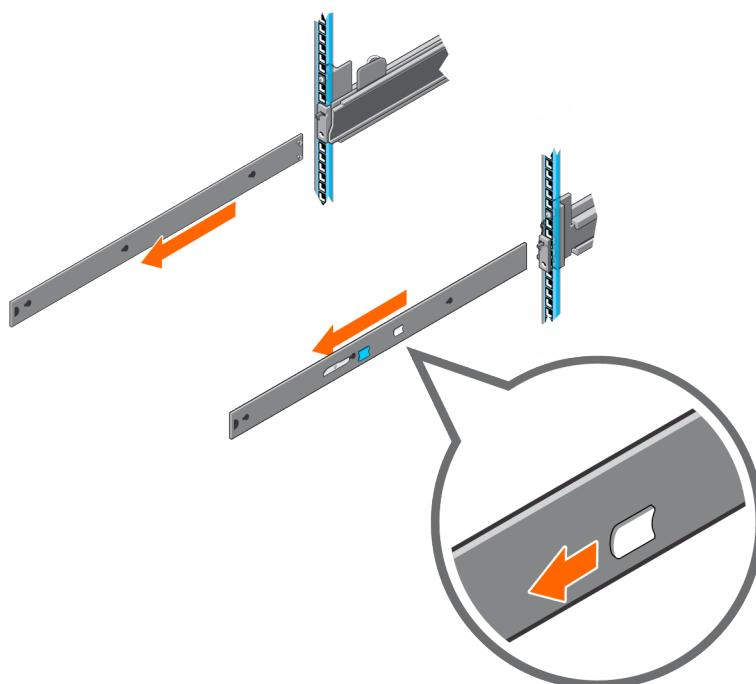


Table 23. Rail component label

Number	Component
1	Intermediate rail
2	Inner rail

3. Attach the inner rails to the sides of the system by aligning the mounting hole on the rail with the standoffs on the system and sliding forward on the system until they lock into place.

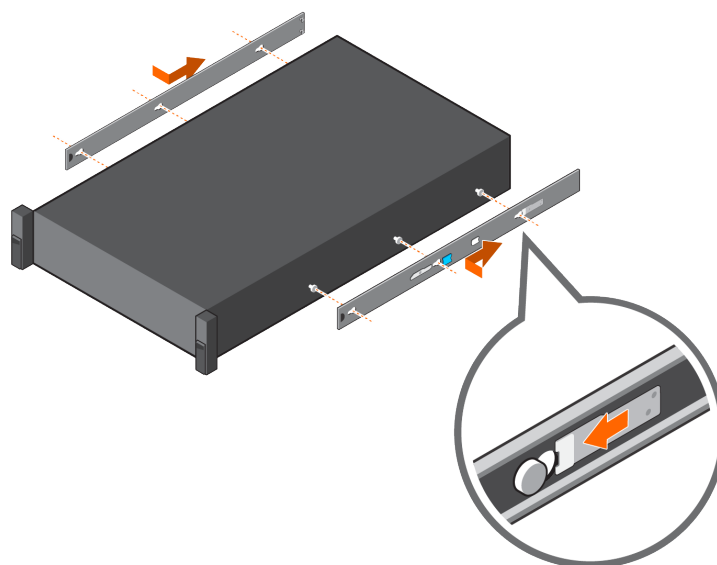


Figure 33. Attach the inner rails to the system

4. Install the system into the extended rails.

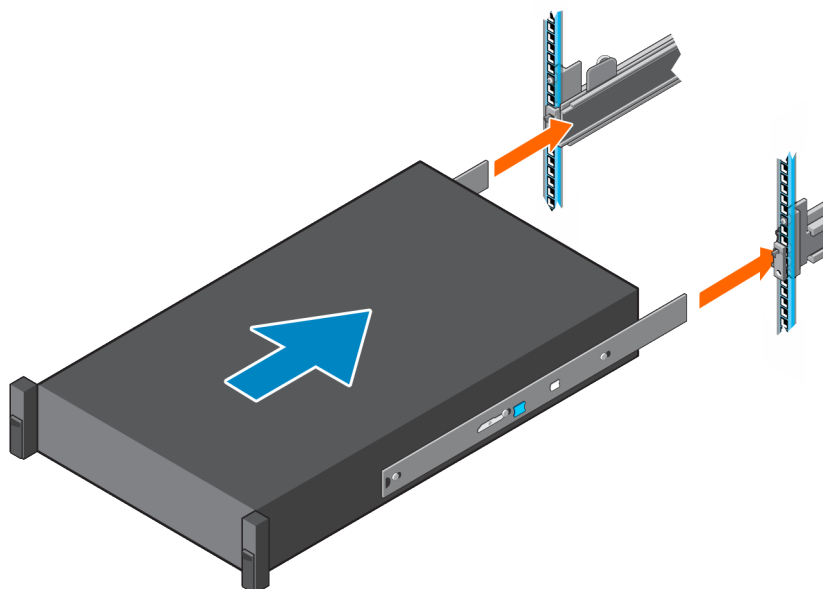


Figure 34. Install system into the extended rails

5. Pull blue slide release lock tabs forward or backward on both rails, and slide the system into the rack.

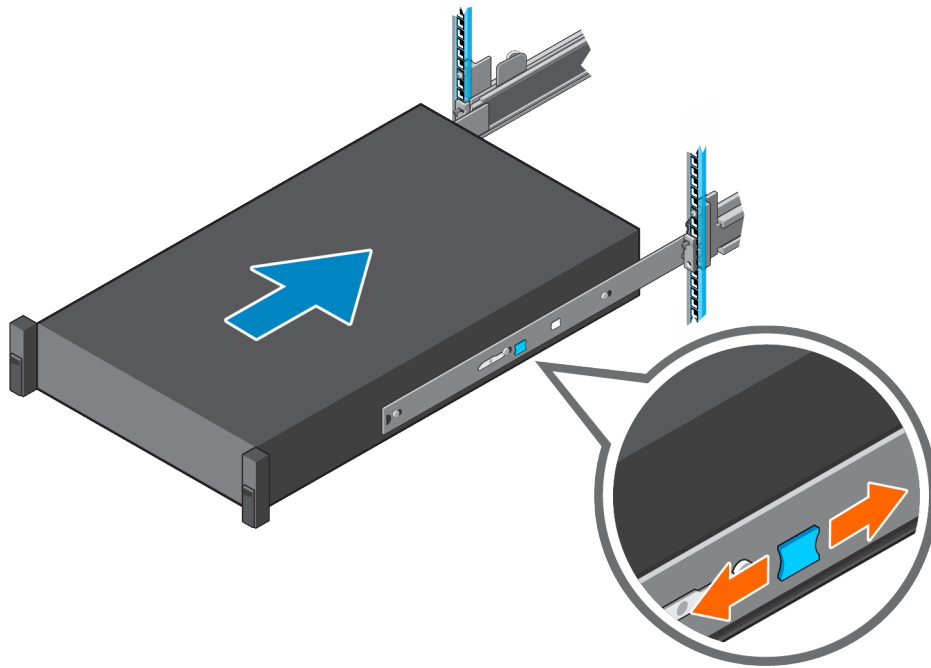


Figure 35. Slide system into the rack

Operating Systems and Virtualization

Topics:

- [Supported Operating Systems](#)

Supported Operating Systems

The PowerEdge system supports the following operating systems:

- Canonical® Ubuntu® Server LTS
- Microsoft® Windows Server® with Hyper-V
- Red Hat® Enterprise Linux
- SUSE® Linux Enterprise server
- VMware® ESXi®

Links to specific OS versions and editions, certification matrices, Hardware Compatibility Lists (HCL) portal, and Hypervisor support are available at [Dell Enterprise Operating Systems](#).

Dell OpenManage Systems Management

Dell delivers management solutions that help IT administrators effectively deploy, update, monitor, and manage IT assets. OpenManage solutions and tools enable you to quickly respond to problems by helping them to manage Dell servers efficiently; in physical, virtual, local, and remote environments; all without the need to install an agent in the operating system.

The OpenManage portfolio includes:

- Innovative embedded management tools - integrated Dell Remote Access Controller (iDRAC)
- Consoles - OpenManage Enterprise
- Extensible with plug-ins - OpenManage Power Manager
- Update tools - Repository Manager

Dell has developed comprehensive systems management solutions that are based on open standards and has integrated with management consoles from partners such as Microsoft and VMware, allowing advanced management of Dell servers. Dell management capabilities extend to offerings from the industry's top systems management vendors and frameworks such as Ansible, Splunk, and ServiceNow. OpenManage tools automate the full span of server life cycle management activities along with powerful RESTful APIs to script or integrate with your choice of frameworks.

For more information about the entire OpenManage portfolio, see:

- The latest [Dell Systems Management Overview Guide](#).

Topics:

- [Integrated Dell Remote Access Controller \(iDRAC\)](#)
- [Systems Management software support matrix](#)

Integrated Dell Remote Access Controller (iDRAC)

iDRAC9 delivers advanced, agent-free, local and remote server administration. Embedded in every PowerEdge server, iDRAC9 provides a secure means to automate a multitude of common management tasks. Because iDRAC is embedded within every PowerEdge server, there is no additional software to install; just plug in power and network cables, and iDRAC is ready to go. Even before installing an operating system (operating system) or hypervisor, IT administrators have a complete set of server management features at their fingertips.

With iDRAC9 in-place across the Dell PowerEdge portfolio, the same IT administration techniques and tools can be applied throughout. This consistent management platform allows easy scaling of PowerEdge servers as an organization's infrastructure grows. Customers can use the iDRAC RESTful API for the latest in scalable administration methods of PowerEdge servers. With this API, iDRAC enables support for the Redfish standard and enhances it with Dell extensions to optimize at-scale management of PowerEdge servers. By having iDRAC at the core, the entire OpenManage portfolio of Systems Management tools allows every customer to tailor an effective, affordable solution for any size environment.

Zero Touch Provisioning (ZTP) is embedded in iDRAC. ZTP - Zero Touch Provisioning is Intelligent Automation Dell's agent-free management puts IT administrators in control. Once a PowerEdge server is connected to power and networking, that system can be monitored and fully managed, whether you're standing in front of the server or remotely over a network. In fact, with no need for software agents, an IT administrator can: • Monitor • Manage • Update • Troubleshoot and remediate Dell servers With features like zero-touch deployment and provisioning, iDRAC Group Manager, and System Lockdown, iDRAC9 is purpose-built to make server administration quick and easy. For those customers whose existing management platform utilizes in-band management, Dell does provide iDRAC Service Module, a lightweight service that can interact with both iDRAC9 and the host operating system to support legacy management platforms.

When ordered with DHCP enabled from the factory, PowerEdge servers can be automatically configured when they are initially powered up and connected to your network. This process uses profile-based configurations that ensure each server is configured per your specifications. This feature requires an iDRAC Enterprise license.

iDRAC9 offers following license tiers:

Table 24. iDRAC9 license tiers

License	Description
iDRAC9 Basic	- Available only on 100-500 series rack/tower - Basic instrumentation with iDRAC web UI - For cost conscious customers that see limited value in management
iDRAC9 Express	- Default on 600+ series rack/tower, modular, and XR series - Includes all features of Basic - Expanded remote management and server life-cycle features
iDRAC9 Enterprise	- Available as an upsell on all servers - Includes all features of Basic and Express. Includes key features such as virtual console, AD/LDAP support, and more - Remote presence features with advanced, Enterprise-class, management capabilities
iDRAC9 Datacenter	- Available as an upsell on all servers - Includes all features of Basic, Express, and Enterprise. Includes key features such as telemetry streaming, Thermal Manage, automated certificate management, and more - Extended remote insight into server details, focused on high end server options, granular power, and thermal management

For a full list of iDRAC features by license tier, see [Integrated Dell Remote Access Controller 9 User's Guide](#) at [Dell.com](#).

For more details on iDRAC9 including white papers and videos, see:

- [Support for Integrated Dell Remote Access Controller 9 \(iDRAC9\)](#) on the [Knowledge Base](#) page at [Dell.com](#)

Systems Management software support matrix

Table 25. Systems Management software support matrix

Categories	Features	PE mainstream
Embedded Management and In-band Services	iDRAC9 (Express, Enterprise, and Datacenter licenses)	Supported
	OpenManage Mobile	Supported
	OM Server Administrator (OMSA)	Supported
	iDRAC Service Module (iSM)	Supported
	Driver Pack	Supported
Change Management	Update Tools (Repository Manager, DSU, Catalogs)	Supported
	Server Update Utility	Supported
	Lifecycle Controller Driver Pack	Supported
	Bootable ISO	Supported
Console and Plug-ins	OpenManage Enterprise	Supported
	Power Manager Plug-in	Supported
	Update Manager Plug-in	Supported
	SupportAssist Plug-in	Supported
	CloudIQ	Supported
Integrations and connections	OM Integration with VMware Vcenter/vROps	Supported
	OM Integration with Microsoft System Center (OMIMSC)	Supported
	Integrations with Microsoft System Center and Windows Admin Center (WAC)	Supported

Table 25. Systems Management software support matrix (continued)

Categories	Features	PE mainstream
	ServiceNow	Supported
	Ansible	Supported
	Third-party Connectors (Nagios, Tivoli, Microfocus)	Supported
Security	Secure Enterprise Key Management	Supported
	Secure Component Verification	Supported
Standard operating system	Red Hat Enterprise Linux, SUSE, Windows Server 2021 Ubuntu, CentOS	Supported (Tier-1)

Appendix D: Service and support

Topics:

- [Default support levels](#)
- [Other services and support information](#)

Default support levels

This system offers 3 years Dell ProSupport Next Business Day (NBD), including 24x7 phone support and NBD parts and labor support.

Default deployment levels

This system is defaulted to the ProDeploy Dell Server which includes onsite hardware installation and remote software configuration. Optionally, the customer may choose to any of the factory or field deployment offers listed below.

Other services and support information

Dell Technologies Services include a wide, customizable range of service options to simplify the assessment, design, implementation, management and maintenance of IT environments and to help transition from platform to platform.

Depending on the current business requirements and correct level of service for customers, we provide factory, onsite, remote, modular, and specialized services that fit the customer requirements and budget. We will help with a little or a lot, based on the customers choice, and provide access to our global resources.

Dell deployment services

[Dell ProDeploy Infrastructure Suite](#)

ProDeploy Infrastructure Suite provides a variety of deployment offerings that satisfy a customer's unique needs. It is made up of 5 offers: ProDeploy Configuration Services, ProDeploy Rack Integration Services, Basic Deployment, ProDeploy, and ProDeploy Plus.

ProDeploy Infrastructure Suite for servers

Versatile choices for accelerated deployments

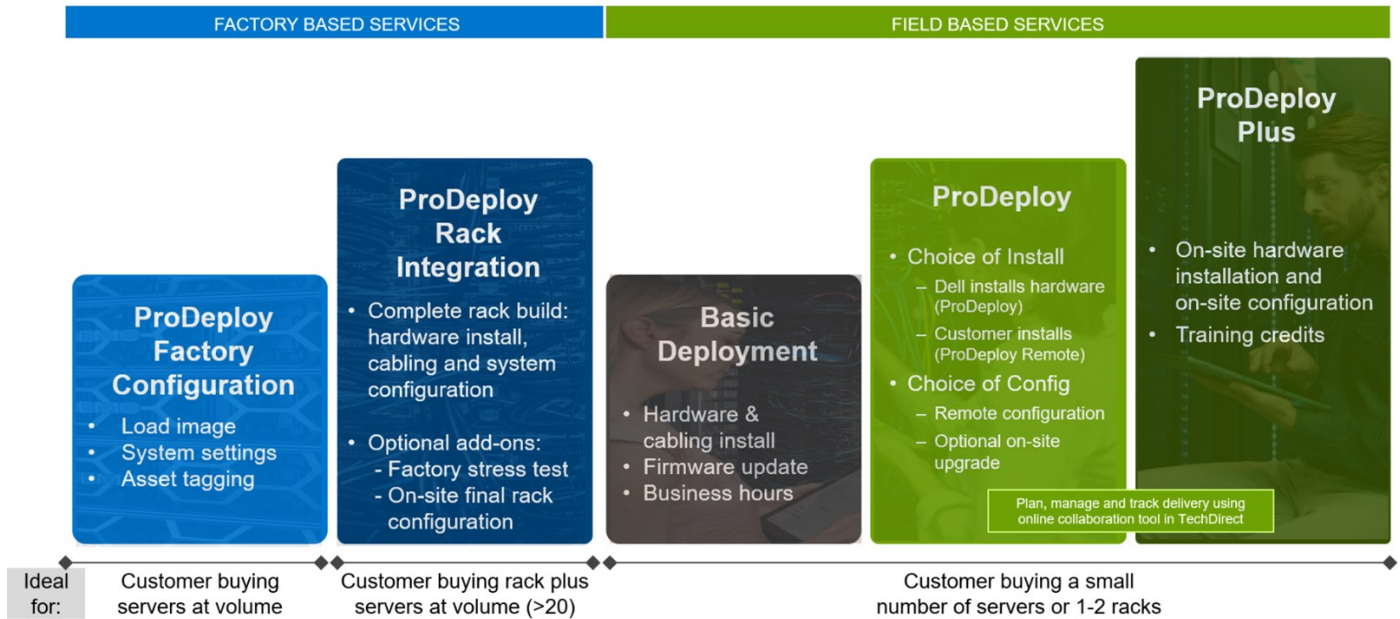


Figure 36. ProDeploy Infrastructure Suite for servers

The new Factory Services consist of two tiers of deployment that happen prior to shipping to the customer's site.

Factory Based Services:

- ProDeploy Factory Configuration - Ideal for customers buying servers in volume and seeking pre-configuration prior to shipping such as: custom image, system settings, and asset tagging so it arrives ready to use out of the box. Furthermore, servers can be packaged and bundled to meet specific shipping and distribution requirements for each customer location to facilitate the rollout process. Upsell one of the field based services (below) if a customer needs assistance with the final server installation.
- ProDeploy Rack Integration - Ideal for customers seeking to build out fully integrated racks prior to shipping. These rack builds include hardware install, cabling, and full system configuration. You can also add-on a factory stress test and optional on-site final rack configuration to complete the rack installation.
 - STANDARD SKUs for Rack Integration is available in US only and requires:
 - 20 or more devices (R and C series servers and all Dell or non-Dell switches). Use Informational SKUs for Dell switches or 3rd party products
 - Shipping to contiguous US
 - USE CUSTOM QUOTE for Rack Integration for:
 - All countries except USA
 - Racks containing less than 20 servers
 - Any rack that includes VxRail or Storage
 - Shipping outside contiguous US
 - Shipping to multiple locations

Field Based Services:

- Basic Deployment consists of the hardware installation, cabling and firmware update during normal standard business hours. Basic Deployment is traditionally sold to Competency Enabled Partners. Competency enabled partners often have Dell do the hardware installation while they complete the software configuration.
- ProDeploy consists of your hardware installation and configuration of the software using offshore resources. ProDeploy is great for customers who are price sensitive or who are remote from their data centers and don't require an onsite presence.
- ProDeploy Plus will give you in-region or onsite resources to complete the engagement for the customer. It also comes with additional features such as Post Deployment Configuration Assistance and Training Credits.

ProDeploy Infrastructure Suite Factory services		FACTORY BASED SERVICES	
		ProDeployFactory Configuration	ProDeploy Rack Integration
Asset configuration	Single point of contact for project management	●	●
	RAID, BIOS and iDRAC configuration	●	●
	Firmware freeze	●	●
	Asset Tagging and Reporting	●	●
	Customer system image	●	●
Factory implementation	Site readiness review and implementation planning	-	●
	Hardware racking and cabling	-	●
	SAM engagement for ProSupport Plus entitled accounts/devices	-	●
	Deployment verification, documentation, and knowledge transfer	●	●
Delivery	White glove logistics	-	●
	Onsite final configuration	-	Onsite add-on
	Install support software and connect with Dell Technologies	-	Onsite add-on
	Basic Deployment	Optional onsite installation	-
Online oversight	Online collaborative environment for planning, managing and tracking delivery	-	●

1 ProDeployRack Integration Services are currently only available within the United States. Custom rack integration services are still available globally*

Internal Use - Confidential 14 of 30 © Copyright 2019 Dell Inc. **DELL** Technologies

Figure 37. ProDeploy Infrastructure Suite - Factory services

ProDeploy Infrastructure Suite Field services		Basic Deployment	ProDeploy	ProDeploy Plus
Pre-deployment	Single point of contact for project management	●	●	In-region
	Site readiness review	-	●	●
	Implementation planning ¹	-	●	●
	SAM engagement for ProSupport Plus entitled devices	-	-	●
Deployment	Deployment service hours	Business hours	24x7	24x7
	Onsite hardware installation and packaging material removal ² or remote guidance for hardware installation ¹	●	Remote guidance or onsite	Onsite
	Install and configure system software	-	Remote	Onsite
	Install support software and connect with Dell Technologies	-	●	●
	Project documentation with knowledge transfer	-	●	●
Post-deployment	Deployment verification	-	●	●
	Configuration data transfer to Dell Technologies technical support	-	●	●
	30-days of post-deployment configuration assistance	-	-	●
	Training credits for Dell Technologies Education Services	-	-	●
Online oversight	Online collaborative environment in TechDirect for planning, managing and tracking delivery ³	-	●	●

¹ Remote option includes project specific instructions, documentation and live expert guidance for hardware installation. Option available for select hardware. [List is available in the backup portion of this customer presentation](#)

² Packaging removal included with onsite hardware installation

³ Included with ProDeploy or ProDeploy Plus, Not included with Basic Deployment

Figure 38. ProDeploy Infrastructure Suite - Field services

Dell ProDeploy Plus for Infrastructure

From beginning to end, ProDeploy Plus provides the skill and scale that is must successfully perform demanding deployments in today's complex IT environments. Certified Dell experts start with extensive environmental assessments and detailed migration

planning and recommendations. Software installation includes set up of our enterprise connectivity solution (secure connect gateway) and OpenManage system management utilities.

Postdeployment configuration assistance, testing, and product orientation services are also available.

Dell ProDeploy for Infrastructure

ProDeploy provides full-service installation and configuration of both server hardware and system software by certified deployment engineers including set up of leading operating systems and hypervisors as well our enterprise connectivity solution (secure connect gateway) and OpenManage system management utilities. To prepare for the deployment, we conduct a site readiness review and implementation planning exercise. System testing, validation, and full project documentation with knowledge transfer complete the process.

Dell Basic Deployment

Basic Deployment delivers worry-free professional installation by experienced technicians who know Dell servers inside and out.

Additional Deployment Services

You can tailor the ProDeploy Infrastructure Suite offer to meet your customer's unique needs by leveraging "Additional Deployment Time." ADT will cover additional tasks above the normal scope of the standard offers. ADT can be sold for Project Management or Technical Resources and is sold as blocks of four hours remote or eight hours on-site.

Dell ProDeploy for HPC (available in US/Canada only. All other regions use custom)

HPC deployments require specialists that understand that cutting edge is yesterday's news. Dell deploys the world 's fastest systems and understands the nuances that make them perform. ProDeploy for HPC provides:

- Global team of dedicated HPC specialists
- Proven track record, thousands of successful HPC deployments
- Design validation, benchmarking, and product orientation

Learn more at Dell.com/HPC-Services.

ProDeploy Expansion for HPC

*Available as standard SKUs in US & Canada and as custom quote in APJC, EMEA, LATAM

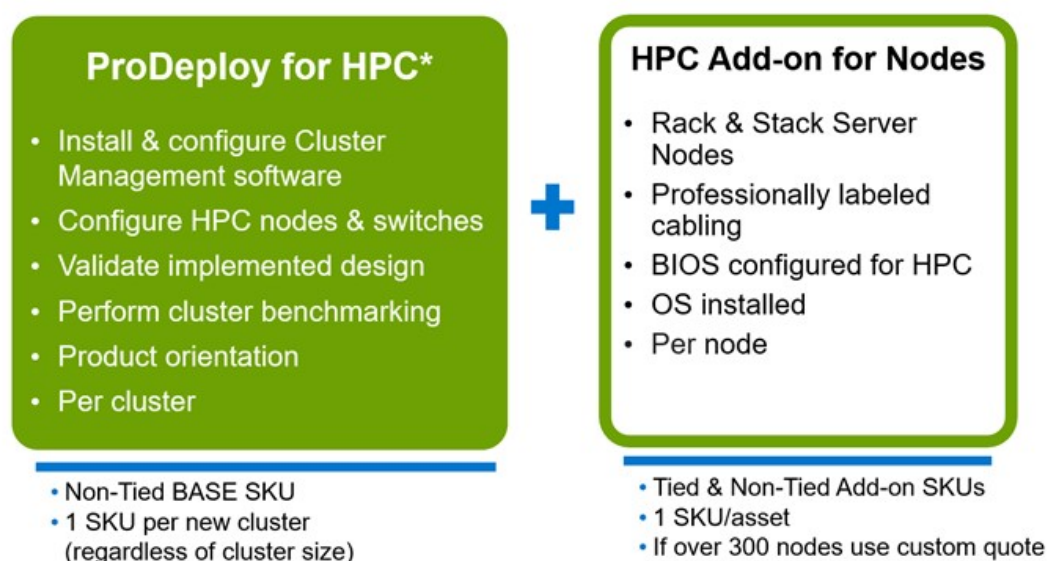


Figure 39. ProDeploy Expansion for HPC

Dell custom deployment Services

Dell custom rack integration and other Dell configuration services help customers save time by providing systems that are racked, cabled, tested, and ready to be integrated into the data center. Dell support preconfigure RAID, BIOS and iDRAC settings, install system images, and even install third-party hardware and software.

For more information, see [Server Configuration Services](#).

Dell Residency Services

Residency Services help customers transition to new capabilities quickly with the assistance of onsite or remote Dell experts whose priorities and time they control.

Residency experts can provide post implementation management and knowledge transfer that is related to a new technology acquisition or day-to-day operational management of the IT infrastructure.

Dell Data Migration Services

Protect business and data of the customer with our single point of contact to manage data migration projects.

A customer project manager works with our experienced team of experts to create a plan using industry-leading tools and proven processes that are based on global best practices to migrate existing files and data, so business systems are up and running quickly and smoothly.

Dell Enterprise Support Services

Dell ProSupport Enterprise Suite

With the ProSupport Enterprise Suite, we help keep IT systems running smoothly, so customers can focus on running their business. We help maintain peak performance and availability of the most essential workloads. ProSupport Enterprise Suite is a suite of support services that enable customers to build the solution that is right for their organization. They choose support models that are based on how they use technology and where they want to allocate resources. From the desktop to the data center, address everyday IT challenges, such as unplanned downtime, mission-critical needs, data and asset protection, support planning, resource allocation, software application management and more. Optimize customer IT resources by choosing the right support model.

Table 26. ProSupport Enterprise Suite

Service	Support model	Description
ProSupport Enterprise Suite	ProSupport Plus for Enterprise	Proactive, predictive, and reactive support for systems that look after your business-critical applications and workloads
	ProSupport for Enterprise	Comprehensive 24 x 7 predictive and reactive support for hardware and software
	Basic hardware support	Reactive hardware support during normal business hours

Dell ProSupport Plus for Enterprise

When customers purchase PowerEdge server, we recommend ProSupport Plus, our proactive and preventative support service for business-critical systems. ProSupport Plus provides all the benefits of ProSupport, plus the following:

- An assigned Services Account Manager who knows their business and environment
- Immediate advanced troubleshooting from an engineer
- Personalized, preventive recommendations that are based on analysis of support trends and best practices from across the Dell Technologies infrastructure solutions customer base to reduce support issues and improve performance
- Predictive analysis for issue prevention and optimization that is enabled by secure connect gateway technology
- Proactive monitoring, issue detection, notification, and automated case creation for accelerated issue resolution enabled by secure connect gateway
- On-demand reporting and analytics-based recommendations that are enabled by secure connect gateway and TechDirect

Dell ProSupport for Enterprise

ProSupport service offers highly trained experts around the clock and around the globe to address IT needs. We help minimize disruptions and maximize availability of PowerEdge server workloads with:

- 24x7 support through phone, chat and online
- Predictive, automated tools and innovative technology
- A central point of accountability for all hardware and software issues
- Collaborative third-party support
- Hypervisor, operating system and application support
- Consistent experience regardless of where customers are located or what language they speak

 **NOTE:** Subject to service offer country or region availability.

- Optional onsite parts and labor response options including next business day or four-hour mission critical

ProSupport Enterprise Suite Feature Comparison		Basic	ProSupport	ProSupport Plus
Remote technical support		9x5	24x7	24x7
Covered products		Hardware	Hardware Software	Hardware Software
Onsite hardware support		Next business day	Next business day or 4hr mission critical	Next business day or 4 hr mission critical
3 rd party collaborative assistance			●	●
Self-service case initiation and management			●	●
Access to software updates			●	●
Proactive storage health monitoring, predictive analytics and anomaly detection with CloudIQ and the CloudIQ mobile app			●	●
Priority access to specialized support experts				●
Predictive detection of hardware failures				●
3 rd party software support				●
An assigned Service Account Manager				●
Proactive, personalized assessments and recommendations				●
Proactive systems maintenance				●

Availability and terms of Dell Technologies Services vary by region and by product. For more information, please view our [service descriptions](#).

Internal Use - Confidential 23 of 117 © Copyright 2022 Dell Inc. **DELL** Technologies

Figure 40. ProSupport Enterprise Suite

Dell ProSupport One for Data Center

ProSupport One for Data Center offers flexible site-wide support for large and distributed data centers with more than 1,000 assets. This offering is built on standard ProSupport components that leverage our global scale but are tailored to a customer's needs. While not for everyone, this service option offers a truly unique solution for Dell Technologies largest customers with the most complex environments.

- Team of assigned Services Account Managers with remote, on-site options
- Assigned ProSupport One technical and field engineers who are trained on the customer's environment and configurations
- On-demand reporting and analytics-based recommendations that are enabled by secure connect gateway and TechDirect
- Flexible on-site support and parts options that fit their operational model
- A tailored support plan and training for their operations staff

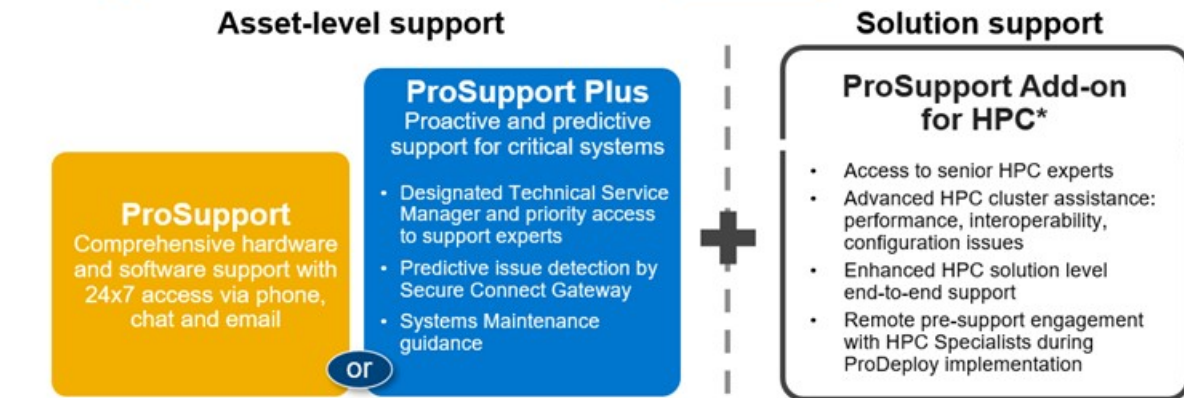
Dell ProSupport Add-on for HPC

The ProSupport Add-on for HPC provides solution-aware support including:

- Access to senior HPC experts
- Advanced HPC cluster assistance: performance, interoperability, and configuration
- Enhanced HPC solution level end-to-end support
- Remote presupport engagement with HPC Specialists during ProDeploy implementation

Learn more at Dell.com/HPC-Services.

ProSupport Add-on for HPC is an add-on to PS or PSP



Eligibility

- All server, storage, and networking nodes in cluster must have PS or PSP **AND** PS Add-on for HPC attached
- All HW expansions to clusters must attach PS or PSP **AND** PS Add-on for HPC
- To retrofit an entire existing cluster with PS Add-on for HPC:
 1. HPC Specialists must review and validate the existing cluster
 2. PS or PSP **AND** the PS Add-on for HPC (APOS) must be attached to all server, storage and networking nodes

*Available in standard SKUs in NA and EMEA and as custom quote in APJC & LATAM

DELLTechnologies

Figure 41. ProSupport Add-on for HPC is an add-on to PS or PSP

Support Technologies

Powering the support experience with predictive, data-driven technologies.

NOTE: SupportAssist Enterprise capabilities are now part of the secure connect gateway technology.

Enterprise connectivity

The best time to solve a problem is before it happens. The automated proactive and predictive support features enabled by the secure connect gateway technology helps reduce steps and time to resolution, often detecting issues before they become a crisis. The gateway technology is available in virtual and application editions. It is also implemented as a direct connect version for select Dell hardware and a Services plugin within OpenManage Enterprise for PowerEdge servers. The legacy SupportAssist Enterprise solution has been retired and is now replaced by the secure connect gateway solutions.

Benefits include:

- Value: Our connectivity solutions are available to all customers at no additional charge
- Improve productivity: Replace manual, high-effort routines with automated support
- Accelerate time to resolution: Receive issue alerts, automatic case creation, and proactive contact from Dell experts
- Gain insight and control: Optimize enterprise devices with insights in portals reporting like TechDirect, and get predictive issue detection before the problem starts

NOTE: Connect devices can access these features. Features vary depending on the service level agreement for the connected device. ProSupport Plus customers experience the full set of automated support capabilities.

Table 27. Features enabled by connectivity

—	Basic hardware warranty	ProSupport	ProSupport Plus
Automated issue detection and system state information collection	Supported	Supported	Supported
Proactive, automated case creation and notification	Not supported	Supported	Supported

Table 27. Features enabled by connectivity (continued)

—	Basic hardware warranty	ProSupport	ProSupport Plus
Predictive issue detection for failure prevention	Not supported	Not supported	Supported

Get started at DellTechnologies.com/secureconnectgateway.

Dell TechDirect

TechDirect helps boost IT team productivity when supporting Dell systems.

Boost your productivity with online service for Dell products from TechDirect. From deployment to technical support, TechDirect lets you do more with less effort and faster resolution. You can:

- Open and manage support requests or in-warranty systems
- Execute online self-service for parts dispatch
- Collaborate on ProDeploy infrastructure deployment projects online
- Manage proactive and predictive alerts from secure connect gateway technology that help maximize uptime
- Integrate services functionality into your help desk with TechDirect APIs
- Join over 10,000 companies that choose TechDirect

Register at TechDirect.Dell.com.

Dell Technologies Consulting Services

Our expert consultants help customers transform faster, and quickly achieve business outcomes for the high value workloads Dell PowerEdge systems can handle. From strategy to full-scale implementation, Dell Technologies Consulting can help determine how to perform IT, workforce, or application transformation. We use prescriptive approaches and proven methodologies that are combined with portfolio and partner ecosystem of Dell Technologies to help achieve real business outcomes. From multi cloud, applications, DevOps, and infrastructure transformations, to business resiliency, data center modernization, analytics, workforce collaboration, and user experiences-we are here to help.

Dell Managed Services

Some customers prefer Dell to manage the complexity and risk of daily IT operations, Dell Managed Services utilizes proactive, AI enabled delivery operations and modern automation to help customers realize desired business outcomes from their infrastructure investments. With these technologies, our experts run, update and fine-tune customer environments aligned with service levels, while providing environment-wide and down-to-the-device visibility. There are two types of managed service offers. First the outsourcing model or CAPEX model where Dell manages the customer owned assets using our people and tools. The second is the as-a-Service model or OPEX model called APEX. In this service, Dell owns all technology and all the management of it. Many customers will have a blend of the two management types depending on the goals of the organization.

Managed	Outsourcing or CAPEX model		APEX	as-a-Service or OPEX model
We manage your technology using our people and tools.¹ • Managed detection and response* • Technology Infrastructure • End-user (PC/desktop) • Service desk operations • Cloud Managed (Pub/Private) • Office365 or Microsoft Endpoint			We own all technology so you can off-load all IT decisions. • APEX Cloud Services • APEX Flex on Demand elastic capacity • APEX Data Center Utility pay-per-use model	

¹ – Some minimum device counts may apply. Order via: ClientManagedServices.sales@dell.com

* Managed detection and response covers the security monitoring of laptops, servers, & virtual servers. Min. 50 devices combined. No Networking or Storage-only systems [SAN/NAS]. Available in 32 countries. [Details here](#)

Figure 42. Dell Managed Services

Dell Technologies Education Services

Build the IT skills required to influence the transformational outcomes of the business. Enable talent and empower teams with the right skills to lead and perform transformational strategy that drives competitive advantage. Leverage the training and certification required for real transformation.

Dell Technologies Education Services offers PowerEdge server training and certifications that are designed to help customers achieve more from their hardware investment. The curriculum delivers the information and the practical, firsthand skills that their team must confidently install, configure, manage, and troubleshoot Dell servers.

To learn more or register for a class today, see Education.Dell.com.

Appendix A: Additional specifications

Topics:

- Chassis dimensions
- Chassis weight
- NIC port specifications
- Video specifications
- USB Ports
- PSU rating
- Environmental specifications

Chassis dimensions

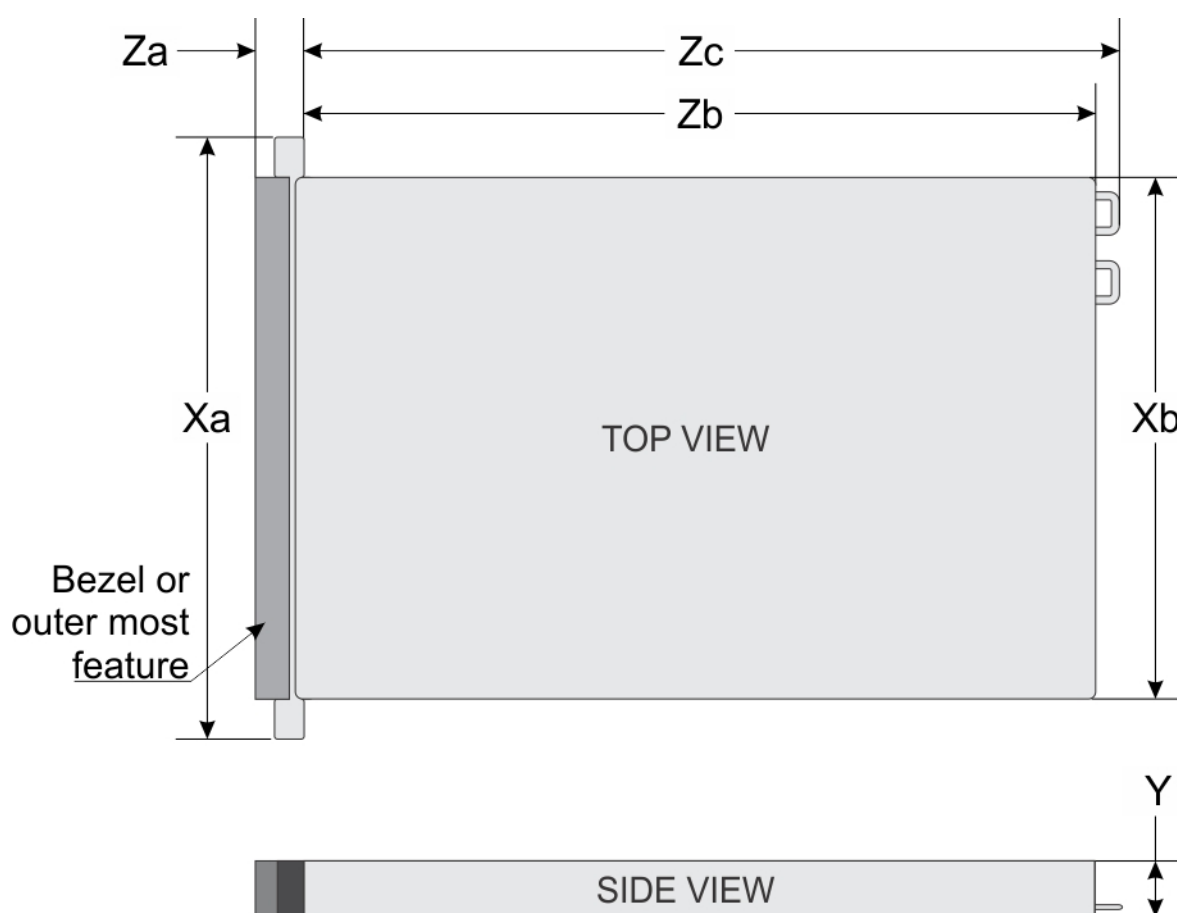


Figure 43. Chassis dimensions

Table 28. PowerEdge R760xd2 chassis dimensions

Drives	Xa	Xb	Y	Za	Zb	Zc
12 drives	481.6 mm (18.960 inches)	448.0 mm (17.637 inches)	86.8 mm (3.417 inches)	35 mm (1.378 inches)	837.0 mm (32.952 inches)	872.74 mm (34.36 inches)

Table 28. PowerEdge R760xd2 chassis dimensions

Drives	Xa	Xb	Y	Za	Zb	Zc
		CC: 434.0 mm (17.08 inches)			Ear to PSU Surface	Ear to PSU handle

NOTE: Zb is the nominal rear wall external surface where the system board I/O connectors reside.

NOTE: Xb is unique to this system and has two values for the Storage module (SM) and the Compute Module (CC) .

Chassis weight

Table 29. PowerEdge R760xd2system weight

System configuration	Maximum weight (with all drives/SSDs)
A server with fully populated drives	46.3 kg (102.07 pounds)
A server without drives and PSU installed	23.72 kg (52.29 pounds)

NIC port specifications

The system supports up to two 10/100/1000 Mbps Network Interface Controller (NIC) ports embedded on the LAN on Motherboard (LOM) and integrated on the optional OCP cards.

Table 30. NIC port specification for the system

Feature	Specifications
LOM	1 GB x 2
OCP card (OCP 3.0)	1 GbE x 4, 10 GbE x 2, 10 GbE x 4, 25 GbE x 2, 25 GbE x 4

Video specifications

The platform supports the following video resolution and refresh rates:

Table 31. Video specifications for R760xd2

Resolution	Refresh Rate	Sestotal Freq.	Pixel Clock	DVO DisplayPort
1024 x 768	60 Hz	48.4 kHz	65.0 MHz	Yes*
1280 x 800	60 Hz	49.7 kHz	83.5 MHz	Yes*
1280 x 1024	60 Hz	64.0 kHz	108.0 MHz	Yes*
1360 x 768	60 Hz	47.71 kHz	85.5 MHz	Yes*
1440 x 900	60 Hz	55.9 kHz	106.5 MHz	Yes*
1600 x 900	60 Hz	55.54 kHz	97.75 MHz	Yes*
1600 x 1200	60 Hz	75.0 kHz	162.0 MHz	Yes*
1680 x 1050	60 Hz	64.7 kHz	119.0 MHz	Yes*
1920 x 1080	60 Hz (RB)	67.158 kHz	173.0 MHz	No
1920 x 1200	60 Hz (RB)	74.556 kHz	193.25 MHz	No

*DVO - DP is for investigation only, dependent on Nuvoton DVO capabilities to support up to 165 MHz.

*(RB) - Reduced Blanking for Digital Displays requiring less blank time. It was introduced for Signal Integrity improvements by reducing Pixel Clock rates for VGA- Analog input devices.

USB Ports

Insert images (right control panel, rear and internal) with labeling of USB Port Locations

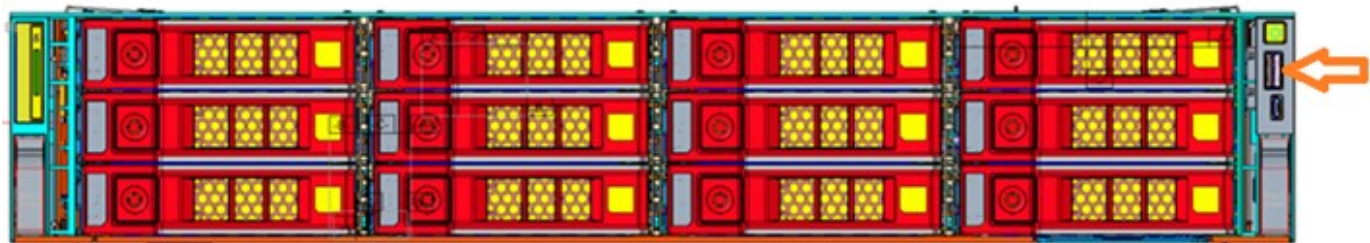


Figure 44. Front USB

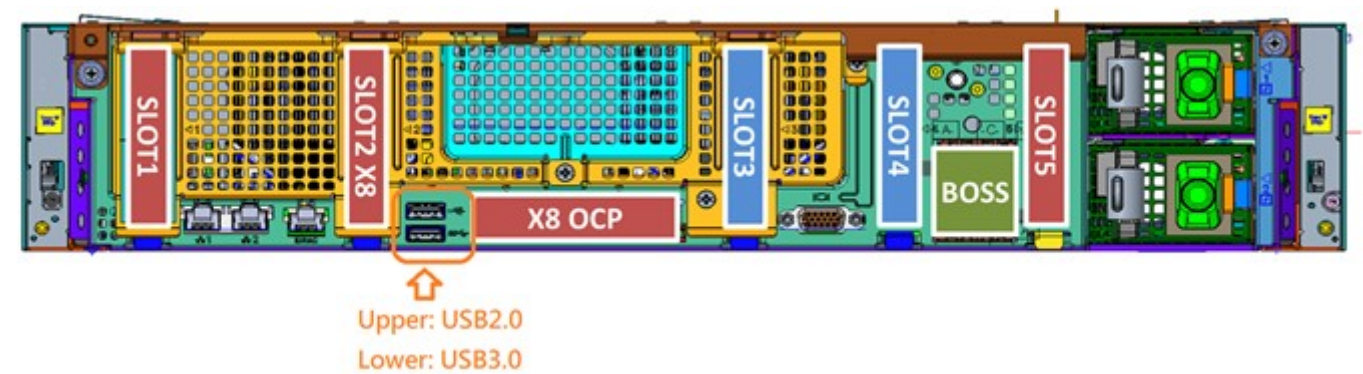


Figure 45. Rear USB

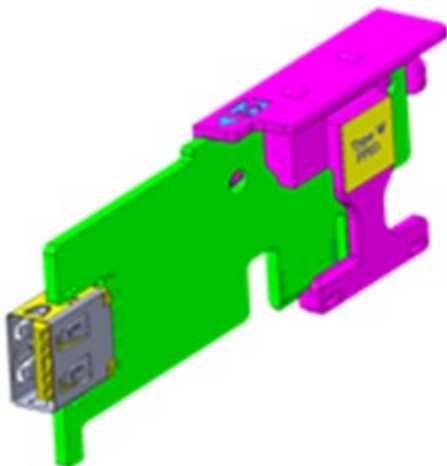


Figure 46. Internal USB

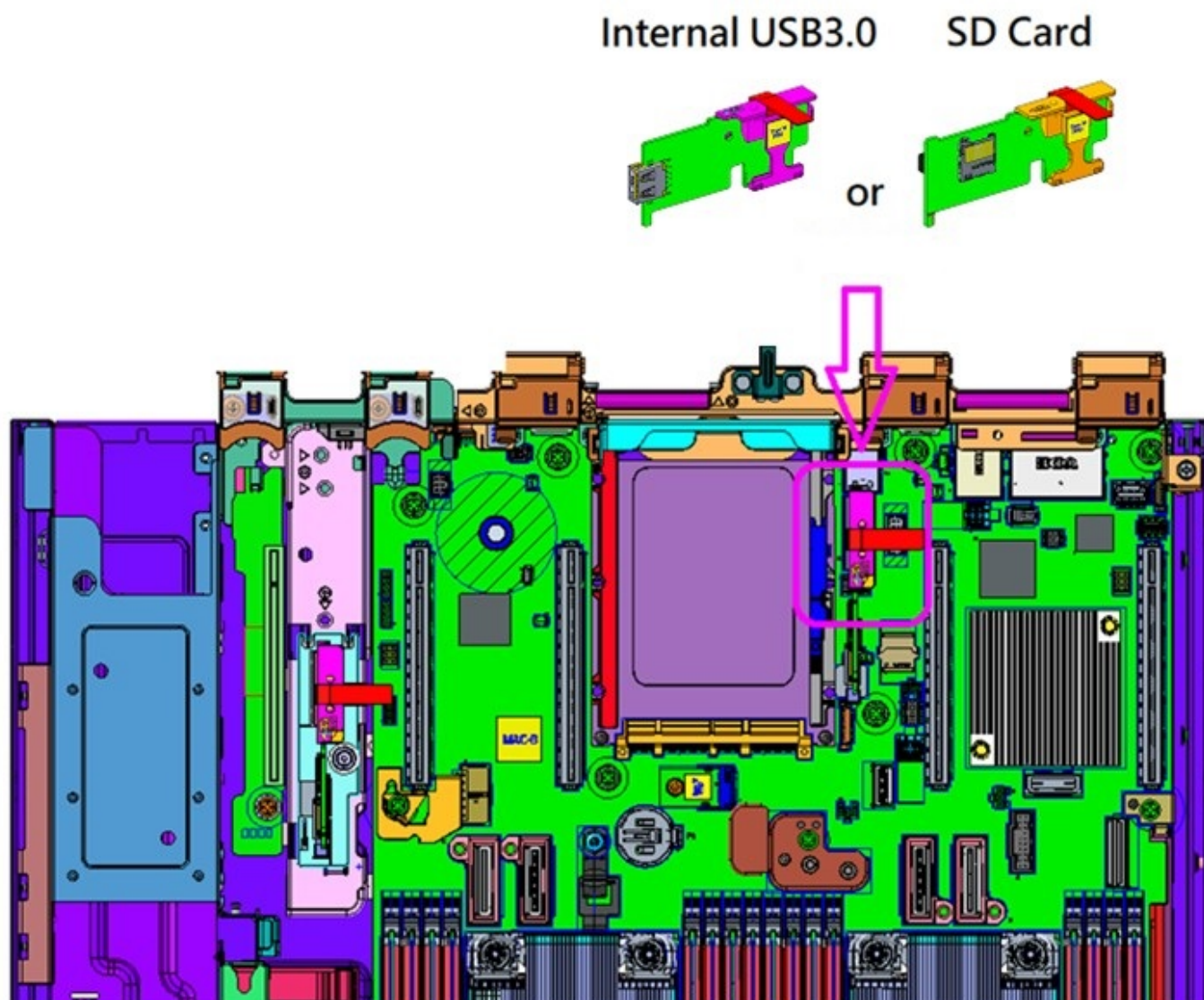


Figure 47. Internal USB Port for Configuration 2A,2B and 2C

Internal USB3.0

SD Card

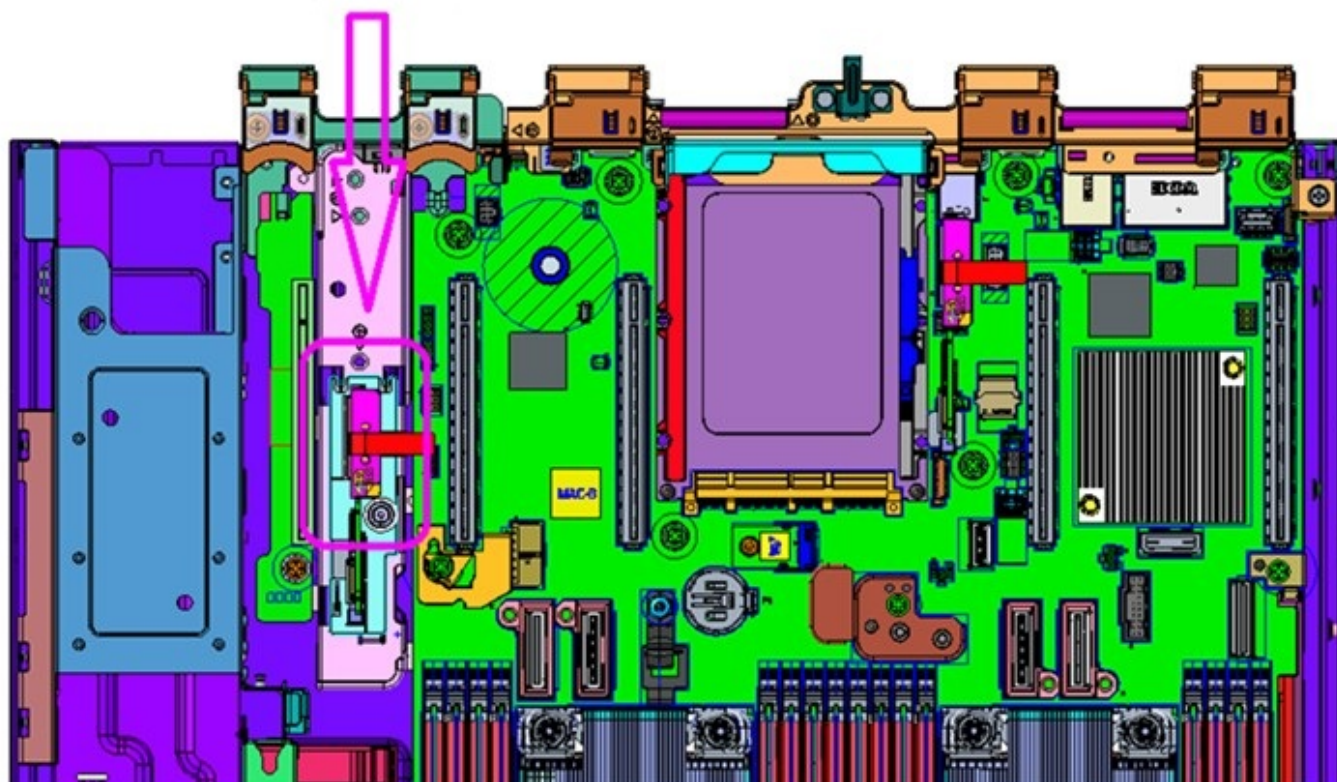
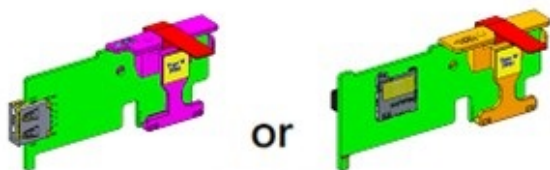


Figure 48. Internal USB Port for Configuration 1-SAS/SATA, 1-NVMe 3A,3B and 3C

Table 32. Systems USB Specifications

Front		Rear		Internal	
USB port type	No. of ports	USB port type	No. of ports	USB port type	No. of ports
USB x 2.0 – compliant port	1	USB x 2.0 – compliant port	1	USB x 3.0 – compliant port	1
		USB x 3.0 – compliant port	1		

Internal USB

The size of the internal USB card dongle is 40 x 16 x 8 mm (L x W x H).

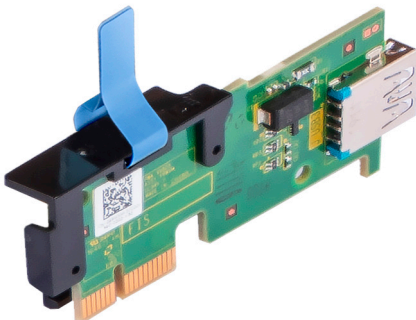


Figure 49. Internal USB

PSU rating

Below table lists the power capacity the PSUs in high/low line operation mode.

Table 33. PSUs highline and lowline ratings

—	700 W Titanium	1100 W Titanium	1400 W Platinum	1800 W Titanium	1100 W VDC
Peak Power (Highline/-72 VDC)	700 W	1100 W	1400 W	1800 W	1100 W
Lowline/-40 VDC	NA	1050 W	1050 W	NA	1100 W
Highline 240 VDC	700 W	1100 W	1400 W	1800 W	NA
Highline 200 ~ 380VDC	NA	NA	NA	NA	NA
DC-48-60 V	NA	NA	NA	NA	1100 W

The PowerEdge R760 supports up to two AC power supplies with 1+1 redundancy, autosensing, and auto switching capability. If two PSUs are present during POST, a comparison is made between the wattage capacities of the PSUs. In case the PSU wattages do not match, the larger of the two PSUs is enabled. Also, there is a PSU mismatch warning that is displayed in BIOS, iDRAC, or on the system LCD.

If a second PSU is added at run-time, in order for that particular PSU to be enabled, the wattage capacity of the first PSU must equal the second PSU. Otherwise, the PSU is flagged as unmatched in iDRAC and the second PSU is not enabled.

Dell PSUs have achieved Platinum efficiency levels as shown in the table below.

Table 34. PSU efficiency level

Efficiency Targets by Load						
Form factor	Output	Class	10%	20%	50%	100%
Redundant 60 mm	700 W AC	Titanium	90.00%	94.00%	96.00%	91.50%
	1100 W AC	Titanium	90.00%	94.00%	96.00%	91.50%
	1100 W VDC	(-48Vdc)	85.00%	90.00%	92.00%	90.00%
	1400 W AC	Platinum	89.00%	93.00%	94.00%	91.50%

Table 34. PSU efficiency level (continued)

Efficiency Targets by Load						
Form factor	Output	Class	10%	20%	50%	100%
	1800 W AC	Titanium	90.00%	94.00%	96.00%	94.00%

Environmental specifications

NOTE: For additional information about environmental certifications, refer to the *Product Environmental Datasheet* located with the *Documentation* on www.dell.com/support/home.

Table 35. Continuous Operation Specifications for ASHRAE A2

Temperature	Specifications
Allowable continuous operations	
Temperature range for altitudes ≤ 900 m (≤ 2953 ft)	10–35°C (50–95°F) with no direct sunlight on the equipment
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 80% RH with 21°C (69.8°F) maximum dew point
Operational altitude de-rating	Maximum temperature is reduced by 1°C/300 m (1.8°F/984 Ft) above 900 m (2953 Ft)

Table 36. Continuous Operation Specifications for ASHRAE A3

Temperature	Specifications
Allowable continuous operations	
Temperature range for altitudes ≤ 900 m (≤ 2953 ft)	5–40°C (41–104°F) with no direct sunlight on the equipment
	Excursion Limited Operation
	5–35°C (41–95°F) Continuous Operation 35–40°C (95–104°F) 10% Annual Runtime
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 85% RH with 24°C (75.2°F) maximum dew point
Operational altitude de-rating	Maximum temperature is reduced by 1°C/175 m (1.8°F/574 Ft) above 900 m (2953 Ft)

Table 37. Continuous Operation Specifications for ASHRAE A4

Temperature	Specifications
Allowable continuous operations	
Temperature range for altitudes ≤ 900 m (≤ 2953 ft)	5–45°C (41–113°F) with no direct sunlight on the equipment
	Excursion Limited Operation
	5–35°C (41–95°F) Continuous Operation 35–40°C (95–104°F) 10% Annual Runtime 40–45°C (104–113°F) 1% Annual Runtime
Humidity percent range (non-condensing at all times)	8% RH with -12°C (10.4°F) minimum dew point to 90% RH with 24°C (75.2°F) maximum dew point
Operational altitude de-rating	Maximum temperature is reduced by 1°C/125 m (1.8°F/410 Ft) above 900 m (2953 Ft)

Table 38. Common Environmental Specifications for ASHRAE A2, A3 and A4

Temperature	Specifications
Allowable continuous operations	
Maximum temperature gradient (applies to both operation and non-operation)	20°C in an hour* (36°F in an hour) and 5°C in 15 minutes (9°F in 15 minutes), 5°C in an hour* (9°F in an hour) for tape hardware <i>i</i> NOTE: * - Per ASHRAE thermal guidelines for tape hardware, these are not instantaneous rates of temperature change.
Non-operational temperature limits	-40 to 65°C (-40 to 149°F)
Non-operational humidity limits	5% to 95% RH with 27°C (80.6°F) maximum dew point
Maximum non-operational altitude	12,000 meters (39,370 feet)
Maximum operational altitude	3,050 meters (10,006 feet)

Table 39. Maximum vibration specifications

Maximum vibration	Specifications
Operating	0.21 G _{rms} at 5 Hz to 500 Hz for 10 minutes (all operation orientations)
Storage	1.88 G _{rms} at 10 Hz to 500 Hz for 15 minutes (all six sides tested)

Table 40. Maximum shock pulse specifications

Maximum shock pulse	Specifications
Operating	Six consecutively executed shock pulses in the positive and negative x, y, and z axis of 6 G for up to 11 ms
Storage	Six consecutively executed shock pulses in the positive and negative x, y, and z axis (one pulse on each side of the system) of 71 G for up to 2 ms

Particulate and gaseous contamination specifications

The following table defines the limitations that help avoid any equipment damage or failure from particulates and gaseous contamination. If the levels of particulates or gaseous pollution exceed the specified limitations and result in equipment damage or failure, you may need to rectify the environmental conditions. Remediation of environmental conditions is the responsibility of the customer.

Table 41. Particulate contamination specifications

Particulate contamination	Specifications
Air filtration	Data center air filtration as defined by ISO Class 8 per ISO 14644-1 with a 95% upper confidence limit <i>i</i> NOTE: This condition applies to data center environments only. Air filtration requirements do not apply to IT equipment designed to be used outside a data center, in environments such as an office or factory floor. <i>i</i> NOTE: Air entering the data center must have MERV11 or MERV13 filtration.
Conductive dust	Air must be free of conductive dust, zinc whiskers, or other conductive particles <i>i</i> NOTE: This condition applies to data center and non-data center environments.
Corrosive dust	- Air must be free of corrosive dust - Residual dust present in the air must have a deliquescent point less than 60% relative humidity

Table 41. Particulate contamination specifications (continued)

Particulate contamination	Specifications
	NOTE: This condition applies to data center and non-data center environments.
Walk-Up Edge Data Center or Cabinet (sealed, closed loop environment)	Filtration is not required for cabinets that are anticipated to be opened 6 times or less per year. Class 8 per ISO 1466-1 filtration as defined above is required otherwise NOTE: In environments commonly above ISA-71 Class G1 or that may have known challenges, special filters may be required.

Table 42. Gaseous contamination specifications

Gaseous contamination	Specifications
Copper coupon corrosion rate	<300 Å/month per Class G1 as defined by ANSI/ISA71.04-2013
Silver coupon corrosion rate	<200 Å/month as defined by ANSI/ISA71.04-2013

Thermal restriction matrix

Table 43. Processor and heat sink matrix

Heat sink	Configuration No
2U HSK	Configuration 1, Configuration 2 and Configuration 3

NOTE: All GPU/FGPA cards require 2U L-type HSK and GPU shroud.

Table 44. Label reference

Label	Description
STD	Standard
HPR (Silver)	High performance (silver grade)
HPR (Gold)	High performance (gold grade)
HSK	Heat sink
LP	Low profile
FH	Full height

Table 45. Thermal restriction matrix

Configuration		Configuration 1 24 x 3.5 inch SAS/SATA		Configuration 2 24 x 3.5 inch SAS/SATA	Configuration 3 24 x 3.5 inch SAS/SATA	Ambient temperature
Rear storage		4 x 3.5 inch SAS/SATA	4 x 2.5 inch NVMe in Carrier Adapter	2 x 2.5 inch	2 x 2.5 inch	
CPU TDP/ cTDP	125 W	STD Fan 2U STD HSK	STD Fan 2U STD HSK	STD Fan 2U STD HSK	STD Fan 2U STD HSK	35°C (95°F)
	150 W	STD Fan 2U STD HSK	STD Fan 2U STD HSK	STD Fan 2U STD HSK	STD Fan 2U STD HSK	35°C (95°F)
	165 W	NA	NA	STD Fan	STD Fan	35°C (95°F)

Table 45. Thermal restriction matrix (continued)

Configuration		Configuration 1 24 x 3.5 inch SAS/SATA		Configuration 2 24 x 3.5 inch SAS/SATA	Configuration 3 24 x 3.5 inch SAS/SATA	Ambient temperature
Rear storage		4 x 3.5 inch SAS/SATA	4 x 2.5 inch NVMe in Carrier Adapter	2 x 2.5 inch	2 x 2.5 inch	
				2U STD HSK	2U STD HSK	
	185 W	NA	NA	STD Fan 2U STD HSK	STD Fan 2U STD HSK	35°C (95°F)

- NOTE:** DDR5 DIMM blank is required for Configuration 3.
- NOTE:** HDD blank is required for all Configurations.
- NOTE:** Restrict HDD capacity up to 7.68TB of 2 x 2.5 inch and 4 x 2.5 inch rear storage.
- NOTE:** System cannot support same type of 2.5 inch drive in front and rear storage (4 x 2.5 inch) when using 2.5 inch HDD adapter in Configuration 1
- NOTE:** System can support PCIe card with cooling Tier equal or lower than Tier 5 (300LFM at 55°C) requirement .
- NOTE:** Need optical transceiver with higher temperature spec (>85°C) supporting in rear OCP.
- NOTE:** Need 30C ambient restriction for 960G BOSS module (21GXV, PRV6C, 7MTJ8, KG8M4, and HN8H6) in Configuration 2 and Configuration 3.
- NOTE:** Single CPU support is there only for configuration 1, configuration 2A and configuration 2B

Table 46. GPU/FPGA thermal restriction matrix

Configuration		Configuration 1 24 x 3.5 inch SAS/SATA		Configuration 2 24 x 3.5 inch SAS/SATA	Configuration 3 24 x 3.5 inch SAS/SATA	Ambient temperature
Rear storage		4 x 3.5 inch SAS/SATA	4 x 2.5 inch NVMe in Carrier Adapter	2 x 2.5 inch	2 x 2.5 inch	
CPU TDP/ cTDP	125 W	NA	NA	NA	STD Fan 2U STD HSK	30°C (86°F)
	150 W	NA	NA	NA	STD Fan 2U STD HSK	30°C (86°F)
	165 W	NA	NA	NA	STD Fan 2U STD HSK	30°C (86°F)
	185 W	NA	NA	NA	STD Fan 2U STD HSK	30°C (86°F)

- NOTE:** Can support GPU in Configuration 3 Only .
- NOTE:** Support LP A2 GPU up to 30°C (86°F) ambient.

-  **NOTE:** DDR5 DIMM blank is required for Configuration 3.
-  **NOTE:** HDD blank is required for all Configurations.
-  **NOTE:** Restrict HDD capacity up to 7.68TB of 2 x 2.5 inch and 4 x 2.5 inch rear storage
-  **NOTE:** System cannot support same type of 2.5 inch drive in front and rear storage (4 x 2.5 inch) when using 2.5 inch HDD adapter in Configuration 1
-  **NOTE:** Need 30C ambient restriction for 960G BOSS module (21GXV, PRV6C, 7MTJ8, KG8M4 and HN8H6) in Configuration 2 and Configuration 3.
-  **NOTE:** Single CPU support is there only for configuration 1, configuration 2A and configuration 2B

Thermal air restrictions

Fresh air environment

- Two PSUs are required in redundant mode. Single PSU failure is not supported.
- BOSS-N1 (M.2) module is not supported.
- GPU and FPGA are not supported.
- Rear storage module is not supported.
- Non-Dell qualified peripheral cards and/or peripheral cards greater than 25 W are not supported.
- OCP card with transmission rate higher than 25G is not supported.
- OCP transceiver spec less than or equal to 70°C (158°F) is not supported.

ASHRAE A3 environment

- Two PSUs are required in redundant mode. Single PSU failure is not supported.
- BOSS-N1 (M.2) module is not supported.
- GPU and FPGA are not supported.
- Rear storage module is not supported.
- Non-Dell qualified peripheral cards and/or peripheral cards greater than 25 W are not supported.
- OCP card with transmission rate higher than 25G is not supported.
- OCP transceiver spec less than or equal to 70°C (158°F) is not supported.

ASHRAE A4 environment

- Two PSUs are required in redundant mode. Single PSU failure is not supported.
- BOSS-N1 (M.2) module is not supported.
- GPU and FPGA are not supported.
- CPU TDP equal or greater than 185 W are not supported.
- Rear storage module is not supported.
- OCP card with transmission rate higher than 25G is not supported.
- OCP transceiver spec less than or equal to 70°C (158°F) is not supported.
- Non-Dell qualified peripheral cards and/or peripheral cards greater than 25 W are not supported.

Appendix A. Standards compliance

The system conforms to the following industry standards.

Table 47. Industry standard documents

Standard	URL for information and specifications
ACPI Advance Configuration and Power Interface Specification, v2.0c	https://uefi.org/specsandtesttools
Ethernet IEEE 802.3-2005	https://standards.ieee.org/
HDG Hardware Design Guide Version 3.0 for Microsoft Windows Server	microsoft.com/whdc/system/platform/pcdesign/designguide/serverdg.mspx
IPMI Intelligent Platform Management Interface, v2.0	intel.com/design/servers/ipmi
DDR5 Memory DDR5 SDRAM Specification	jedec.org/standards-documents/docs/jesd79-4.pdf
PCI Express PCI Express Base Specification Rev. 2.0 and 3.0	pcisig.com/specifications/pciexpress
PMBus Power System Management Protocol Specification, v1.2	http://pmbus.org/Assets/PDFS/Public/PMBus_Specification_Part_I_Rev_1-1_20070205.pdf
SAS Serial Attached SCSI, v1.1	http://www.t10.org/
SATA Serial ATA Rev. 2.6; SATA II, SATA 1.0a Extensions, Rev. 1.2	sata-io.org
SMBIOS System Management BIOS Reference Specification, v2.7	dmtf.org/standards/smbios
TPM Trusted Platform Module Specification, v1.2 and v2.0	trustedcomputinggroup.org
UEFI Unified Extensible Firmware Interface Specification, v2.1	uefi.org/specifications
USB Universal Serial Bus Specification, Rev. 2.7	usb.org/developers/docs

Appendix C Additional resources

Table 48. Additional resources

Resource	Description of contents	Location
Installation and Service Manual	This manual, available in PDF format, provides the following information: • Chassis features • System Setup program • System indicator codes • System BIOS • Remove and replace procedures • Diagnostics • Jumpers and connectors	Dell.com/Support/Manuals
Getting Started Guide	This guide ships with the system, and is also available in PDF format. This guide provides the following information: • Initial setup steps	Dell.com/Support/Manuals
Rack Installation Guide	This document ships with the rack kits, and provides instructions for installing a server in a rack.	Dell.com/Support/Manuals
System Information Label	The system information label documents the system board layout and system jumper settings. Text is minimized due to space limitations and translation considerations. The label size is standardized across platforms.	Inside the system chassis cover
Quick Resource Locator (QRL)	This code on the chassis can be scanned by a phone application to access additional information and resources for the server, including videos, reference materials, service tag information, and Dell contact information.	Inside the system chassis cover
Enterprise Infrastructure Planning Tool (EIPT)	The Dell online EIPT enables easier and more meaningful estimates to help you determine the most efficient configuration possible. Use EIPT to calculate the power consumption of your hardware, power infrastructure, and storage.	Dell.com/calc